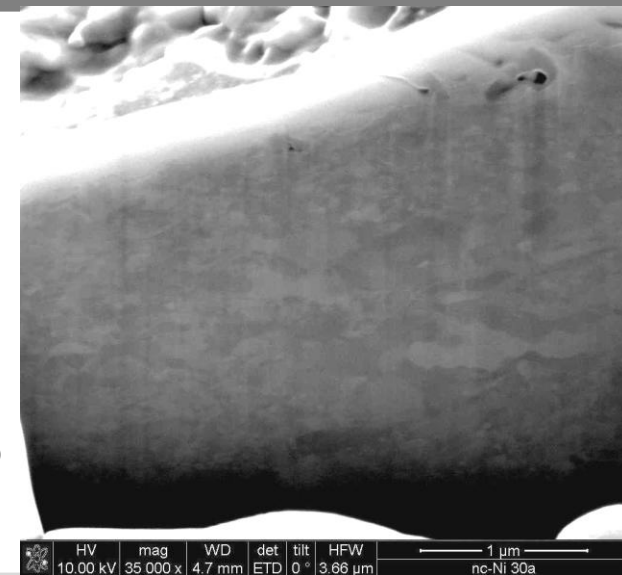
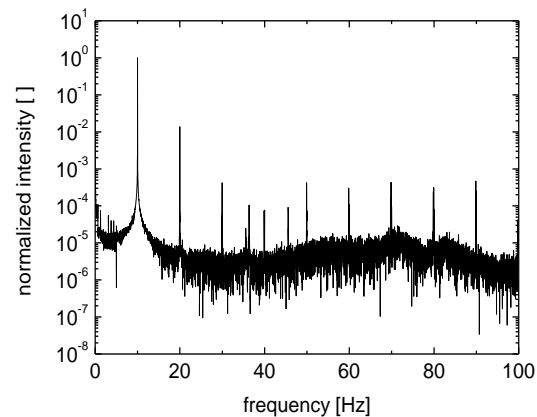
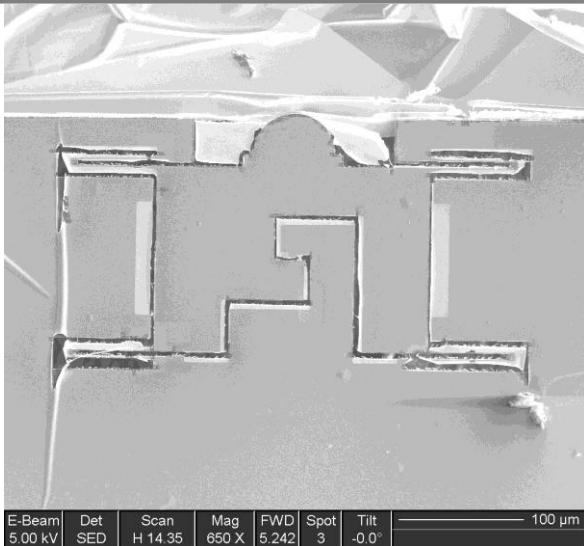


Fatigue of nanostructured materials

Matthias Funk, Christoph Eberl
Karlsruhe Institute of Technology, Germany
Seminarvortrag, 18./19.07.2011

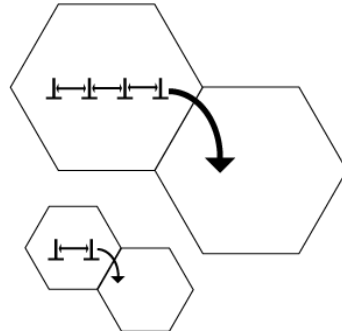
Institute of Applied Materials, KIT



Overview - Projects

- Fatigue of nc-Ni: investigation of deformation mechanisms
- In-situ tests on nc-Cu: to observe microstructure during fatigue
(with A. Castrup, INT, A. Minor, LBNL, Berkeley, USA)
- Nanotwinned (nt)-Cu: determination of tensile and fatigue properties
(with T. Kennerknecht, KIT, Xingjang Chang, Texas, USA)
- Fourier Transform (FT) analysis of fatigue data: tool to quantify nonlinearity and inelasticity
(with V. Baroso, J. Höpfner, M. Wilhelm, Polymer Chemistry, KIT)

Grain size > 100 nm



Grain size < 100 nm

$$\sigma = \sigma_0 + \frac{k_y}{\sqrt{D}}$$

Properties:

- Enhanced properties following the Hall-Petch relation (strength, hardness, wear resistance)
- Enhanced fatigue properties in HCF
- Reduced ductility due to reduced dislocation activity

[Padilla & Boyce, *Exp Mech*, 2006]

[Kumar et al., *Acta Mater*, 2003]

Interests:

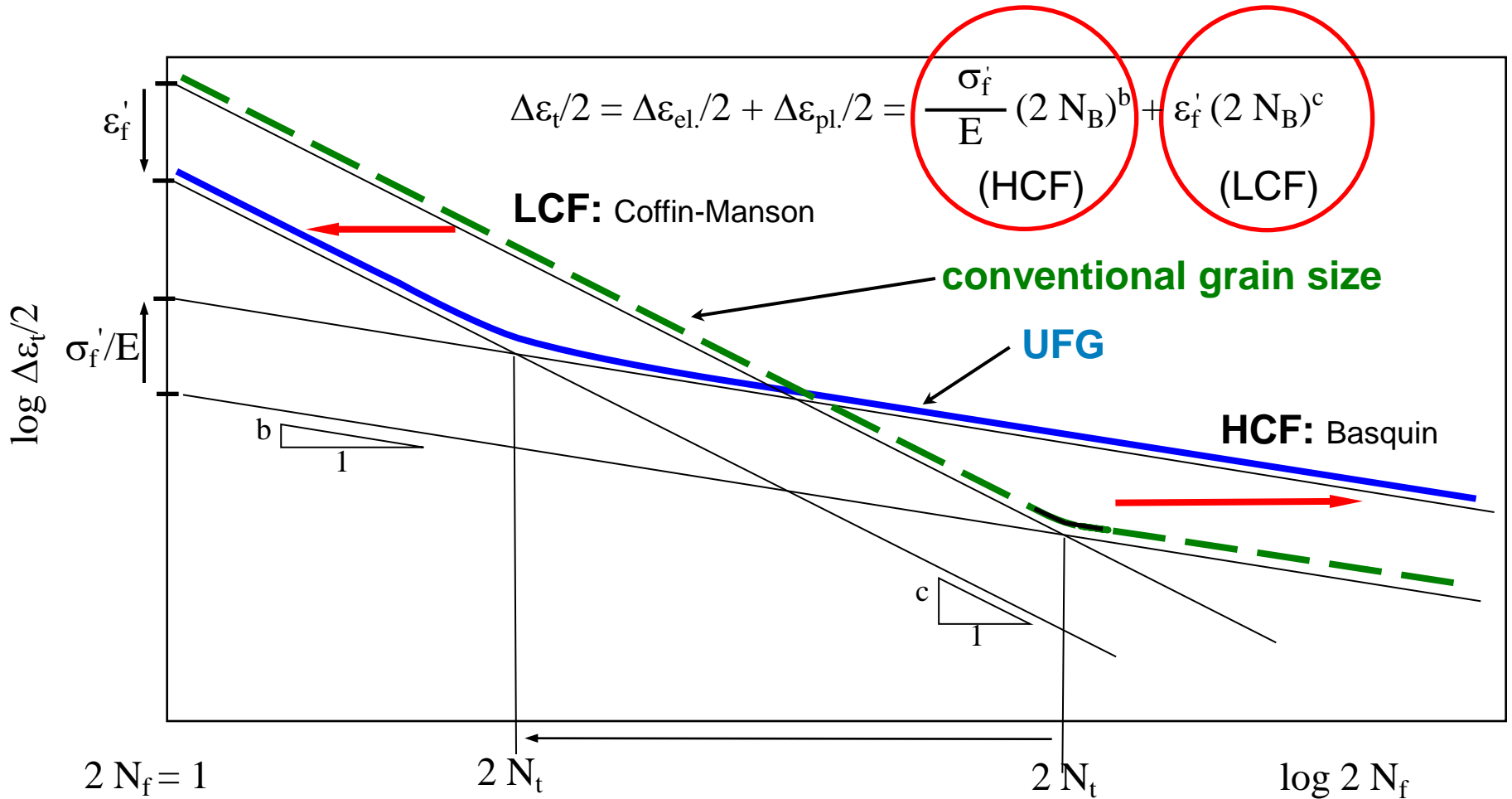
- Different deformation mechanisms as in cg materials
- Size / scaling effects
- Grain coarsening ↔ crack initiation

[Furuya et al., *Scr. Mat.*, 2008]

[Simons et al., *Mater Sci Eng A*, 2006]

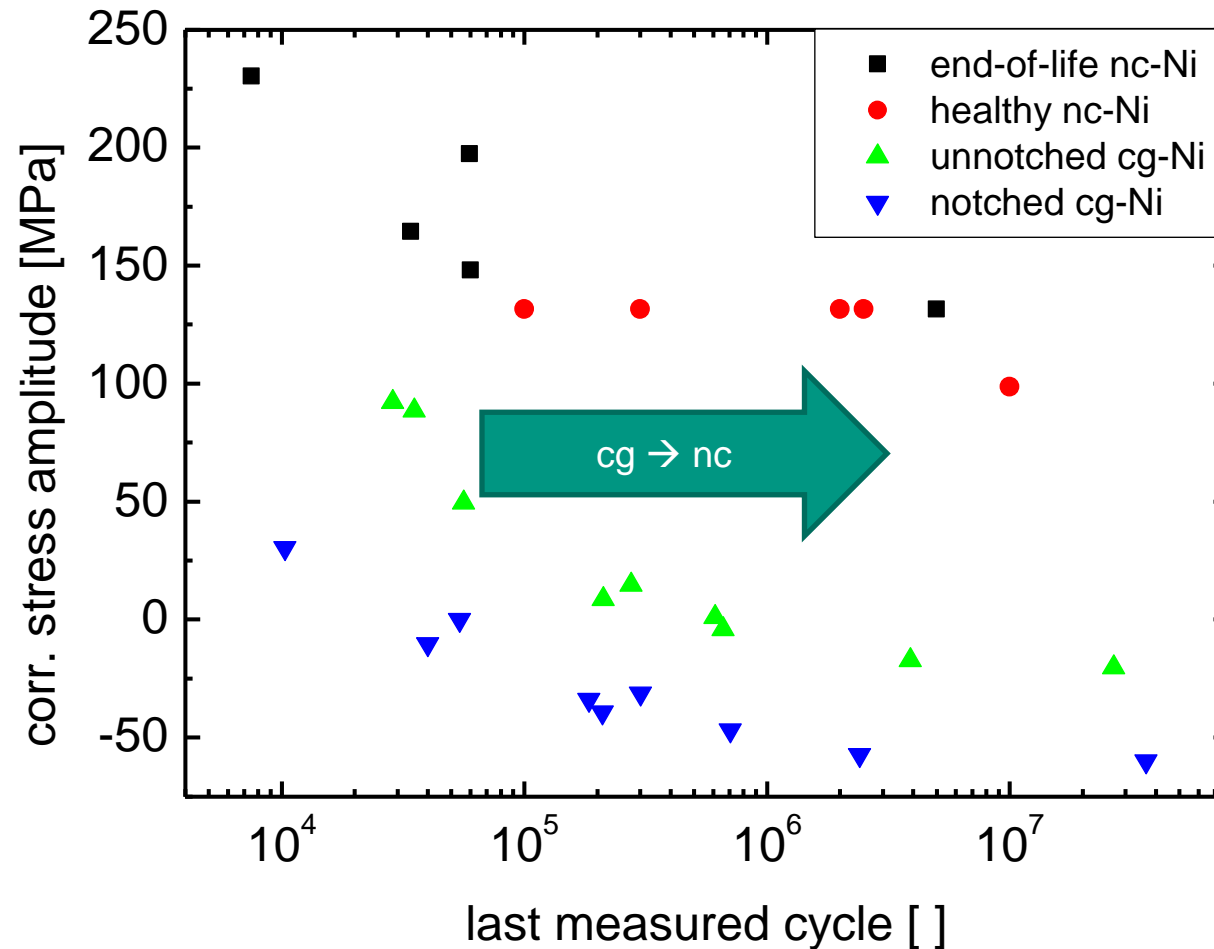
fatigue of nanocrystalline materials

Fatigue of nc materials



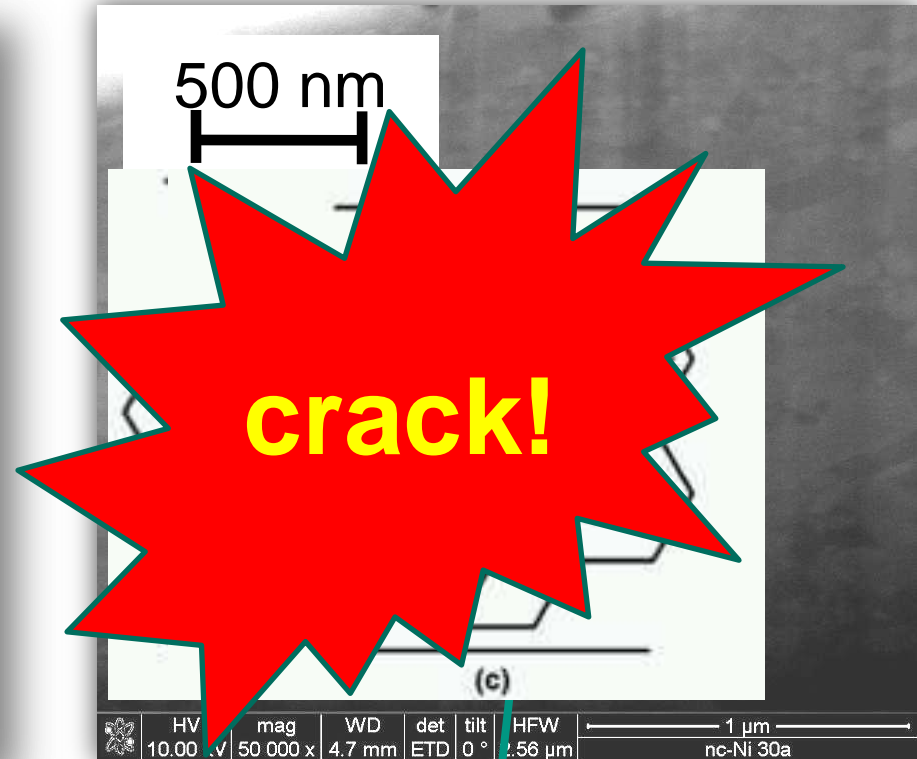
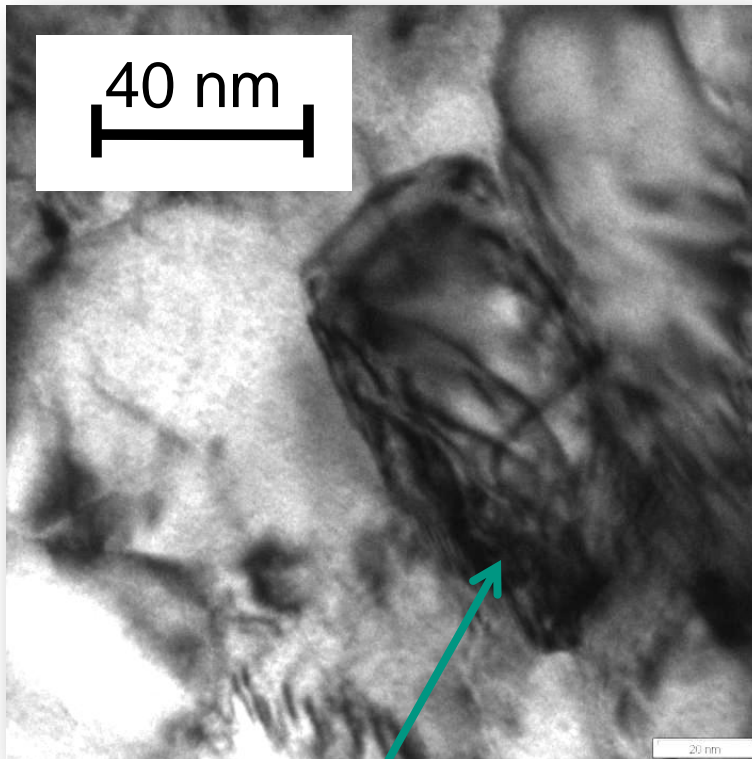
[Mughrabi & Höppel, *MRS*, 2000]

Fatigue of nc materials



σ_m (cg-Ni) = 200 MPa values from [Son, et al., *Scripta Mater* 50, 2004]
 σ_m (nc-Ni) = 200 – 300 MPa

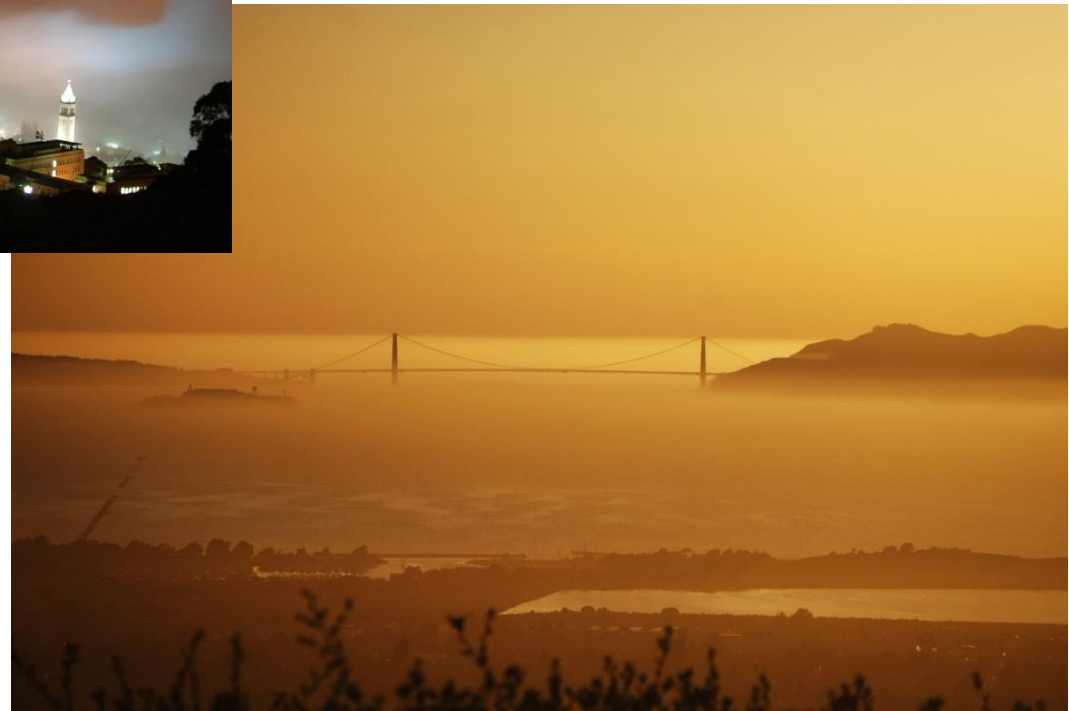
Fatigue of nanocrystalline metals - Motivation



What happens inside the „nano-grains“? Full dislocations or only partials and twins?

Grain rotation could lead to coalescence (grain coarsening).

[Meyers, *Progr Mater Sci*, 2006]



In-situ fatigue of nc-Cu

In-situ TEM

WHAT???

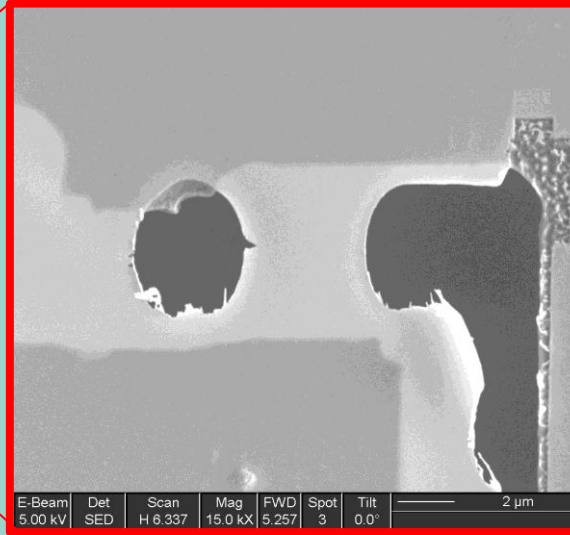
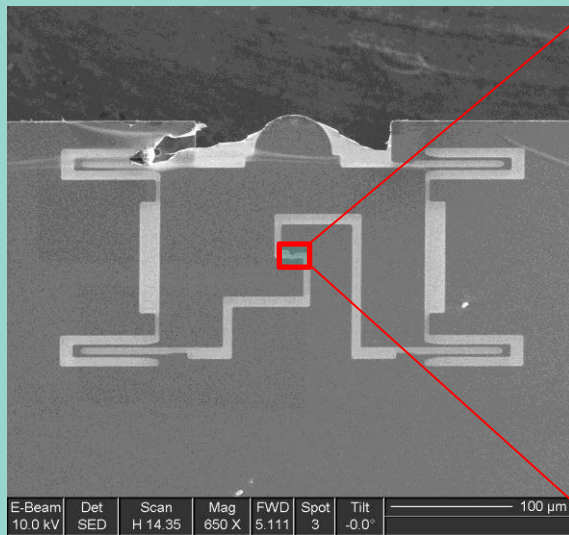
In-situ tests (tensional monotonic and cyclic) in the TEM with nc-Cu

WHY???

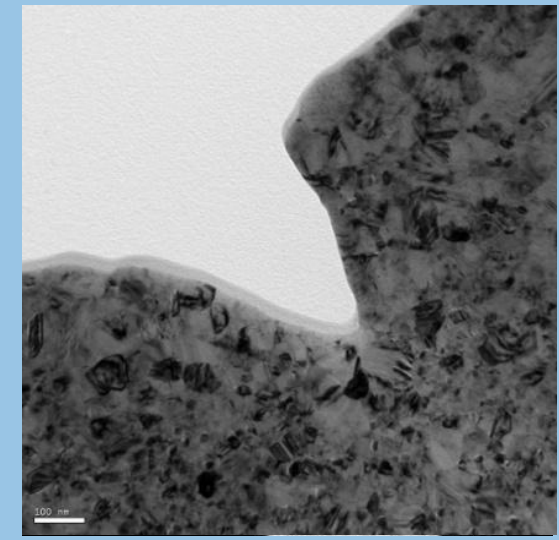
- To „see“ processes that dominate deformation in nc metals
- To test small sample volumes

FIB

Cutting free the MEMS and the sample



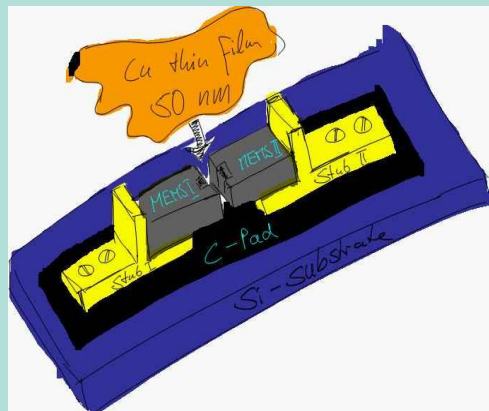
TEM
Fatigue testing



Samples – preparation and testing

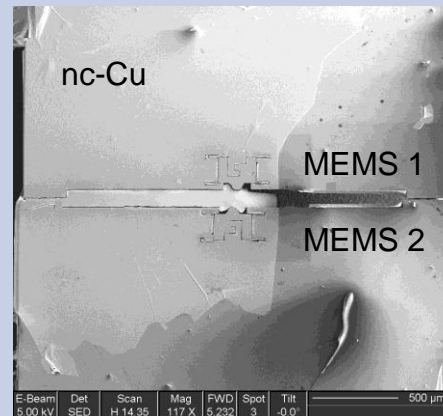
The 60 nm thick samples were electrodeposited on a mica plate with a 5 nm thick C-film between mica and nc-Cu.

1. Transferring the Film



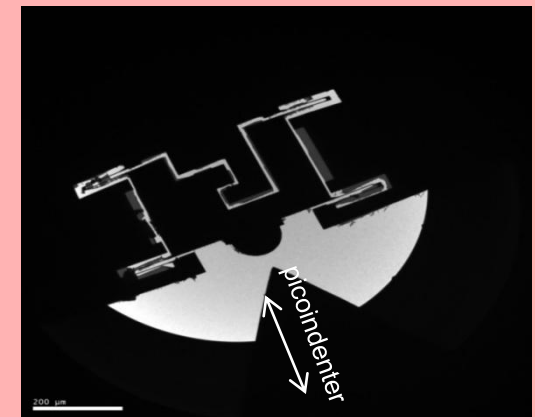
Film is going off the mica plate. Floating on a liquid and sinking on the MEMS' testing section.

2. FIB - cutting



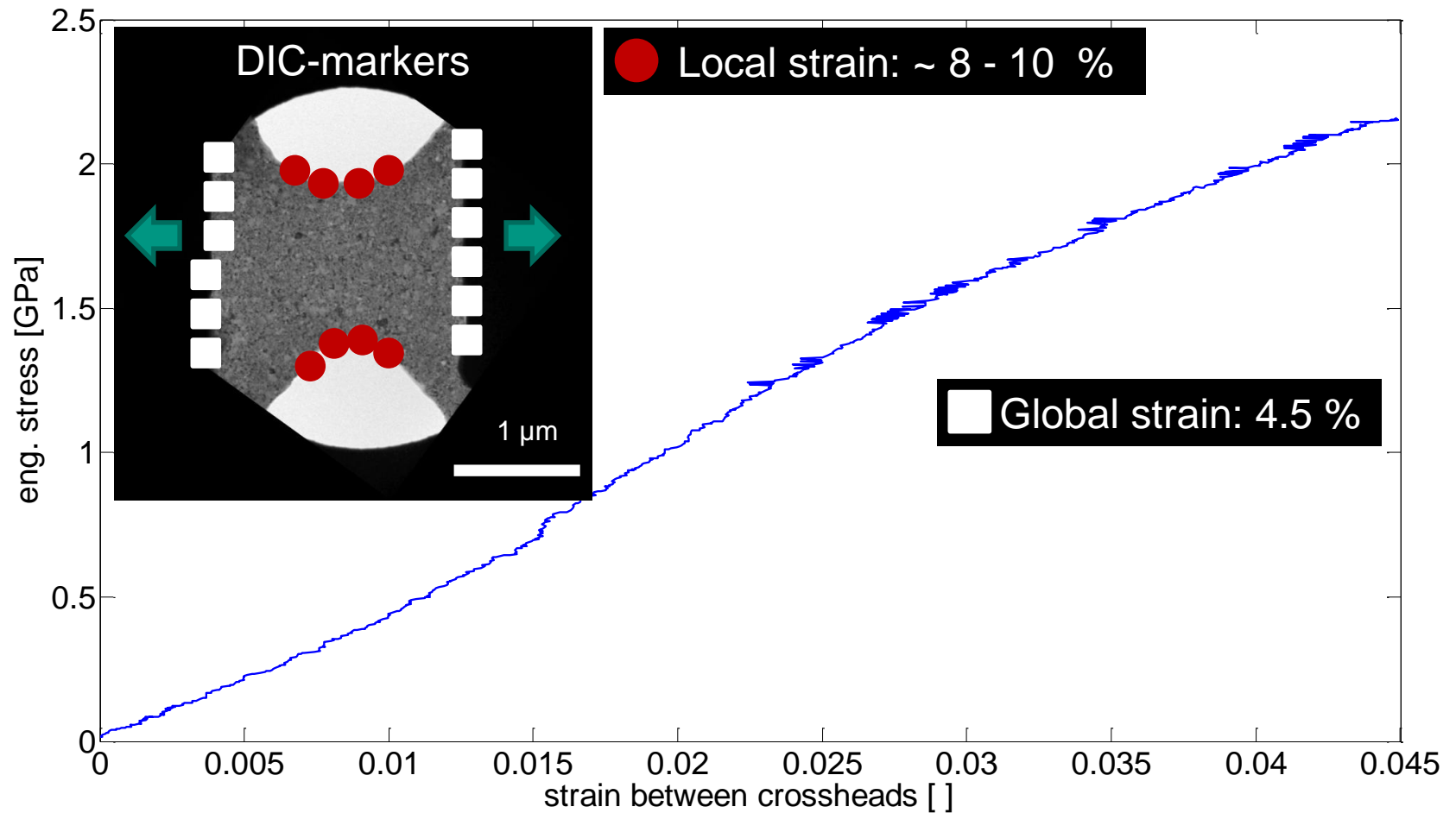
Film is drying and attached to the MEMS. Cutting free the mechanics along edges.

3. TEM - testing



Picoindenter is pushing on the MEMS in the TEM. Compression is transformed into tensional load and sample is strained.

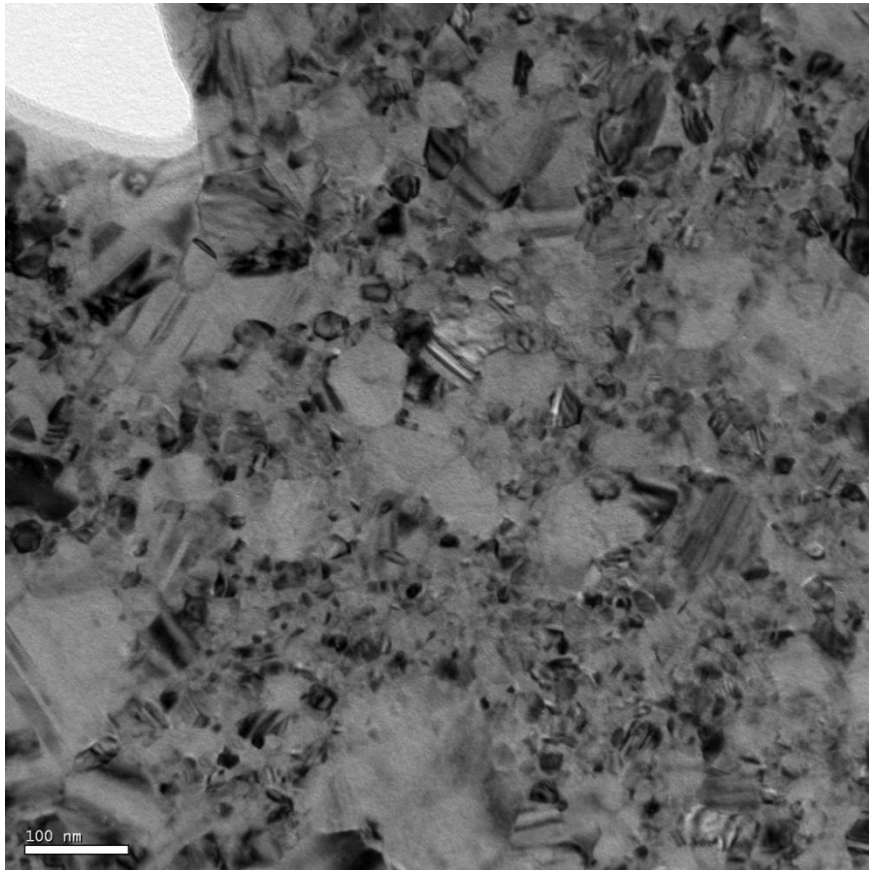
Stress-Strain Curve



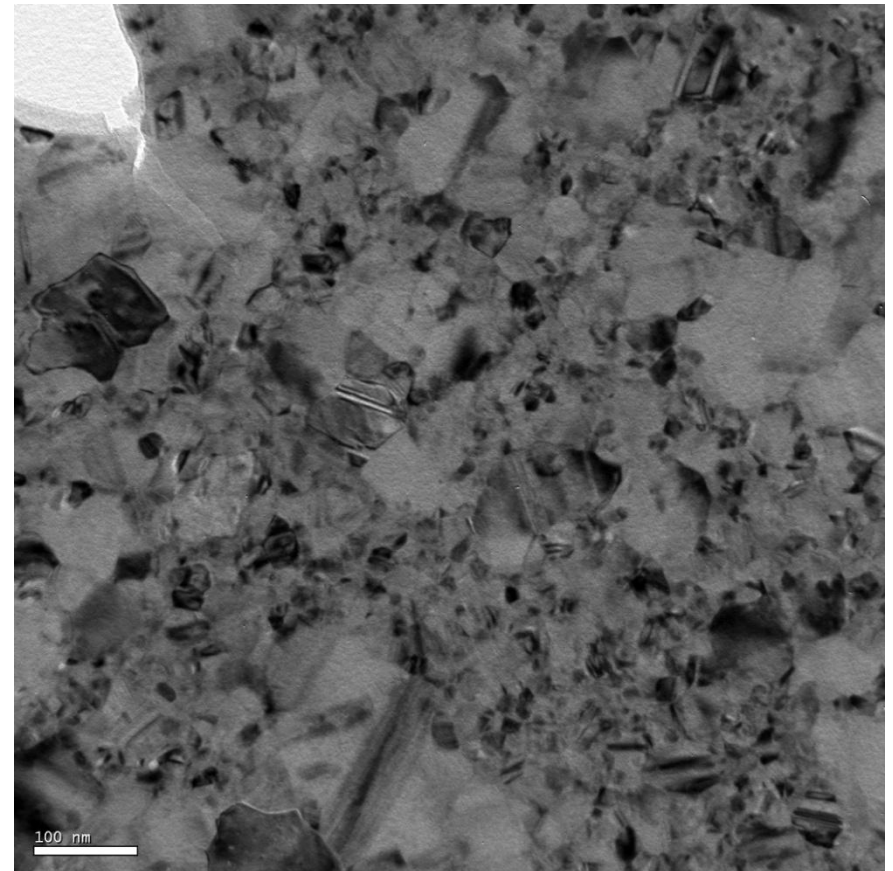
Thickness of nc-Cu ~ 65 nm \rightarrow Young's modulus of ~ 50 GPa,

Fatigue of a notched sample

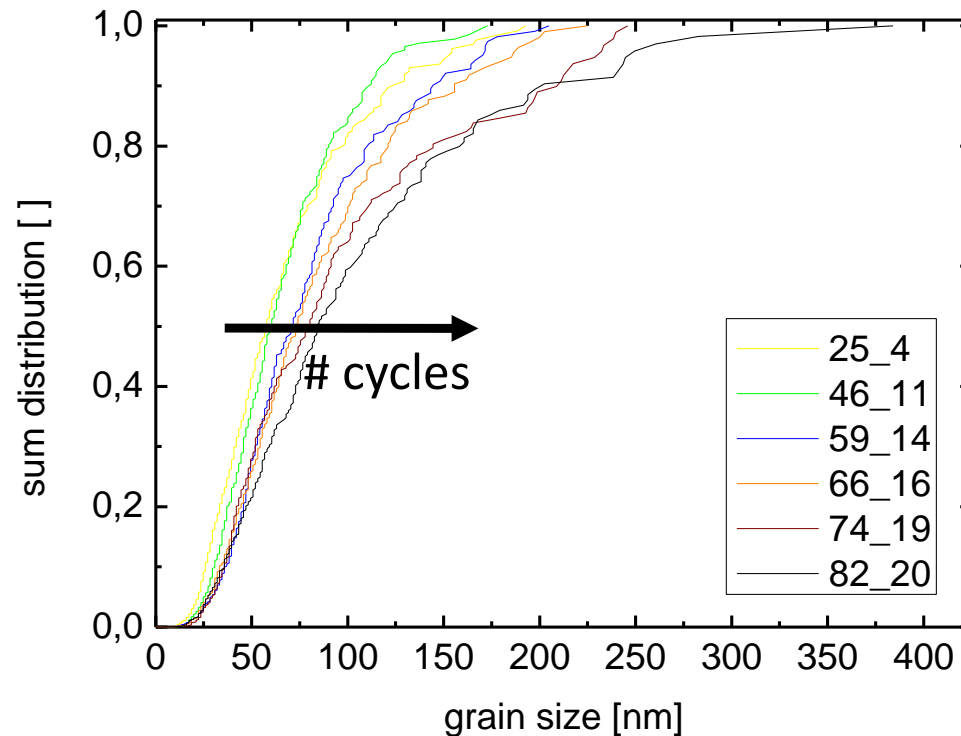
After 8th cycle



After 9th cycle



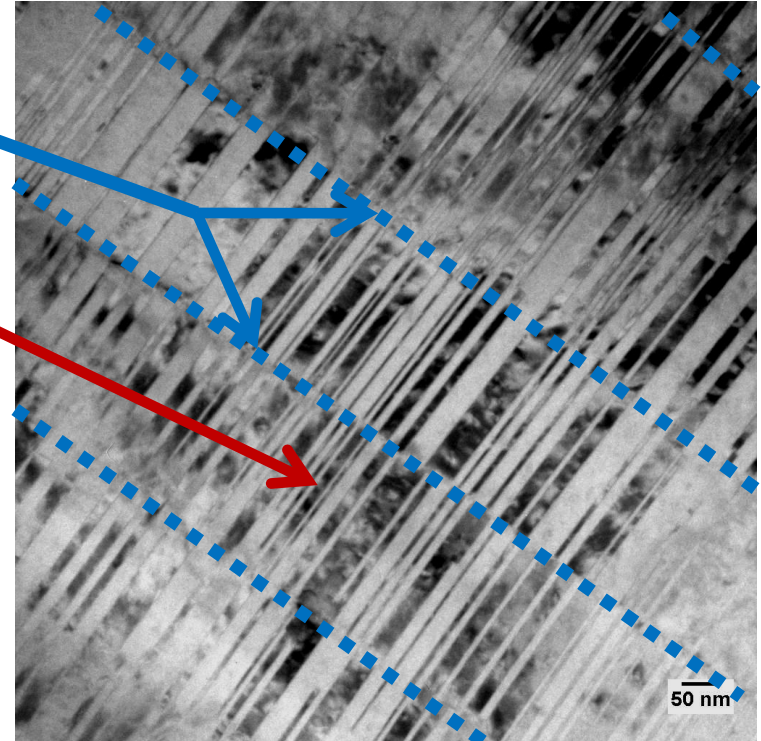
Grain coarsening during fatigue



Ultra fine grained
microstructure

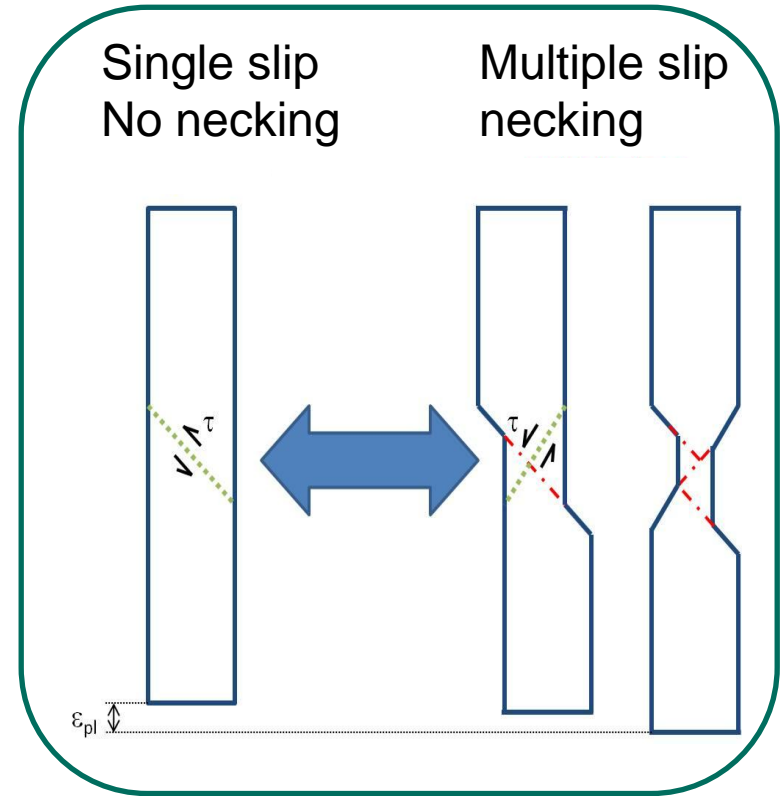
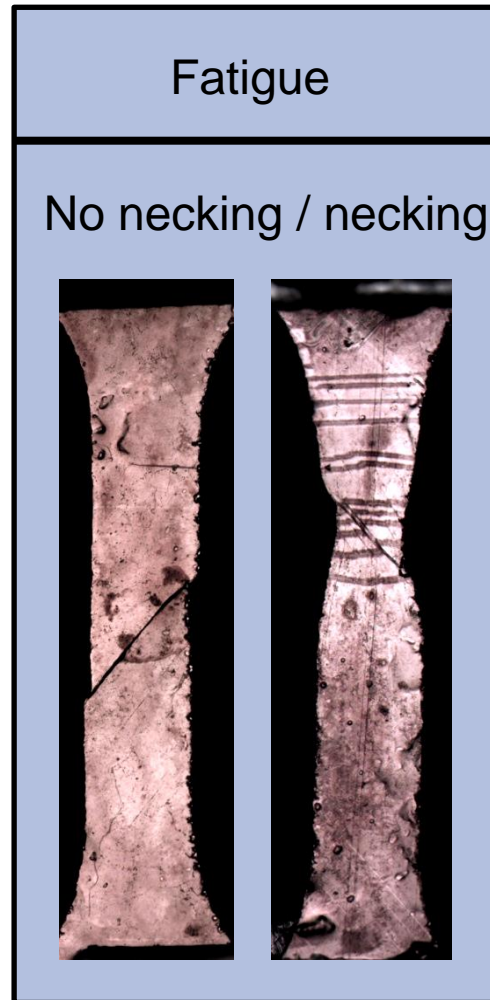
Lamella
distance of
5 – 50 nm

- + similar Hall-Petch-hardening than in nc
- + dislocation activity → ductility
- Deposition is time consuming (sputtered)



Nanotwinned Copper

Mechanical testing: No necking / necking

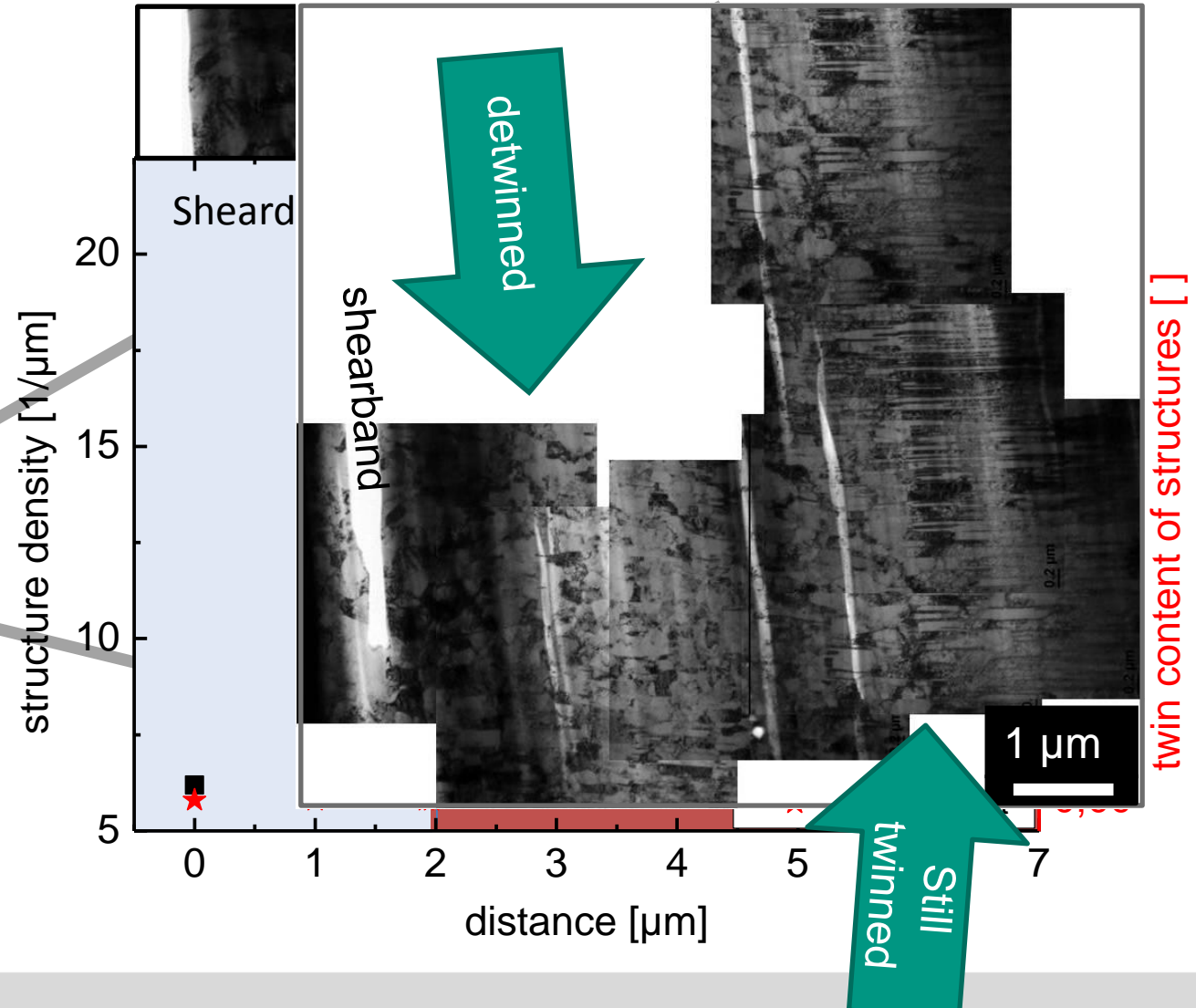
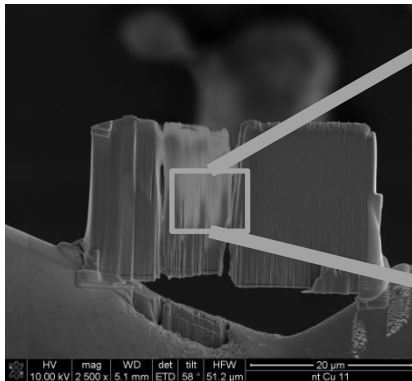


depending on diffusion / strain rate
→ Single / multiple slip

[Tests done by T. Kennerknecht]

Fatigued nt Cu

TEM lamella of the region around the shear band

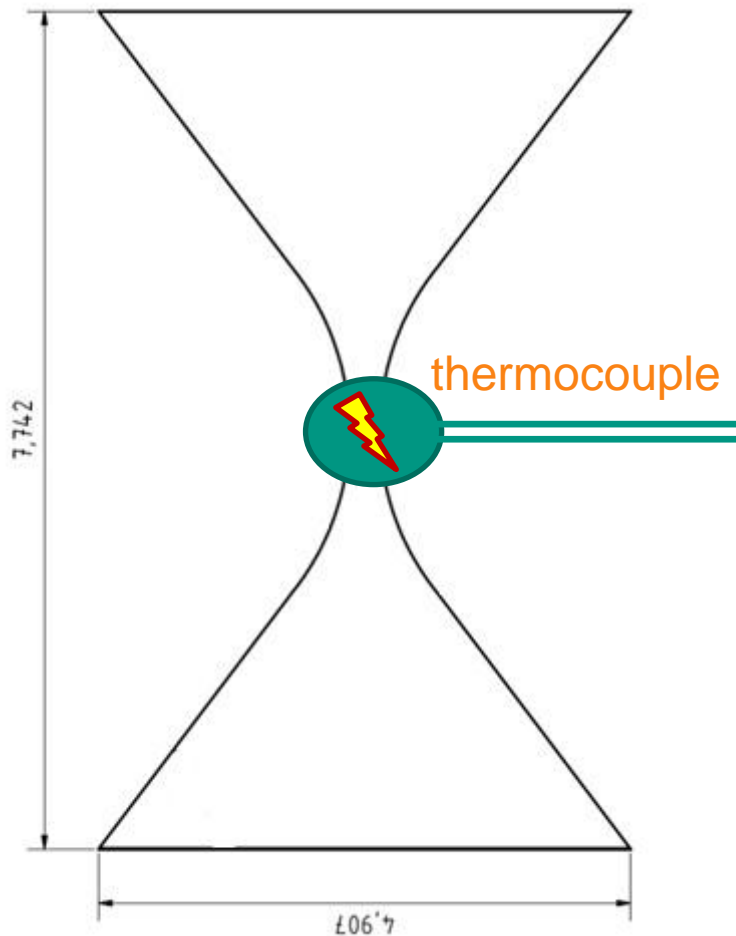


How much
When will
nonlinearity is in
the sample
the defor-
break?!?
mation?!?



Fourier Transform (FT) analysis

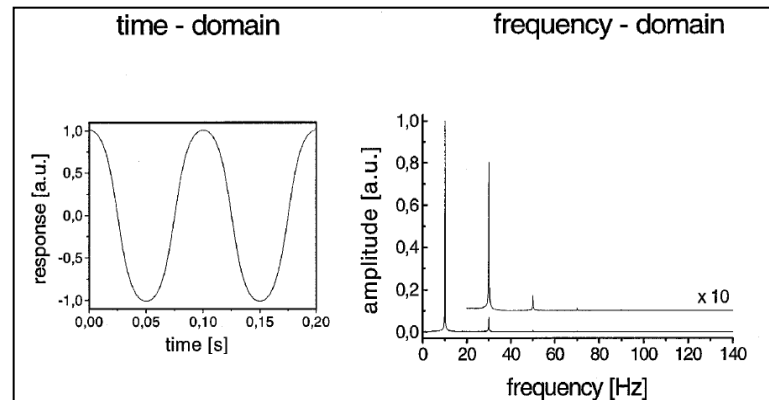
Motivation



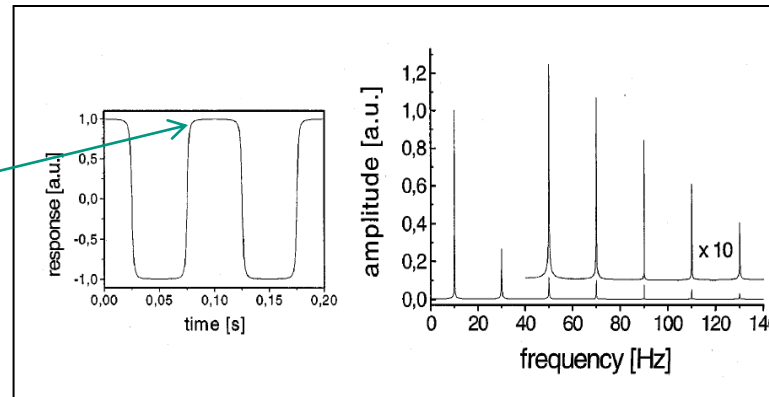
- + Quantitative evaluation of nonlinear fraction of fatigue signals (fingerprint)
- + Applicable for any kind of response signal e.g. torsion, bending, tensile...
- + Contactless analysis of fatigue signals (valuable especially for nc and nt materials)

FT-Analysis of fatigue-signals

Fouriertransform-rheology with polymers –
 harmonics are proportional to nonlinear fraction (Wilhelm)



Nonlinear
 fraction
 ~
 Damage,
 degradation



[Wilhelm et al., *Rheol Acta*, 1998]

FT- Analysis: setup, parameters, samples

GABO – Eplexor 150 N



Intent

Correlation: degradation \longleftrightarrow nonlinearity

Materials & samples

Nanocrystalline Ni (grain size < 100 nm)

Coarse grained Ni (conventional and MSG)

Cross section: $\sim 0.056 \text{ mm}^2$

Acquisition parameter

Scan rate: 50 kHz

Box-oversampling: 250 pts.

→ Effective sampling rate: 200 Hz

Acquisition time of segments: 60 s

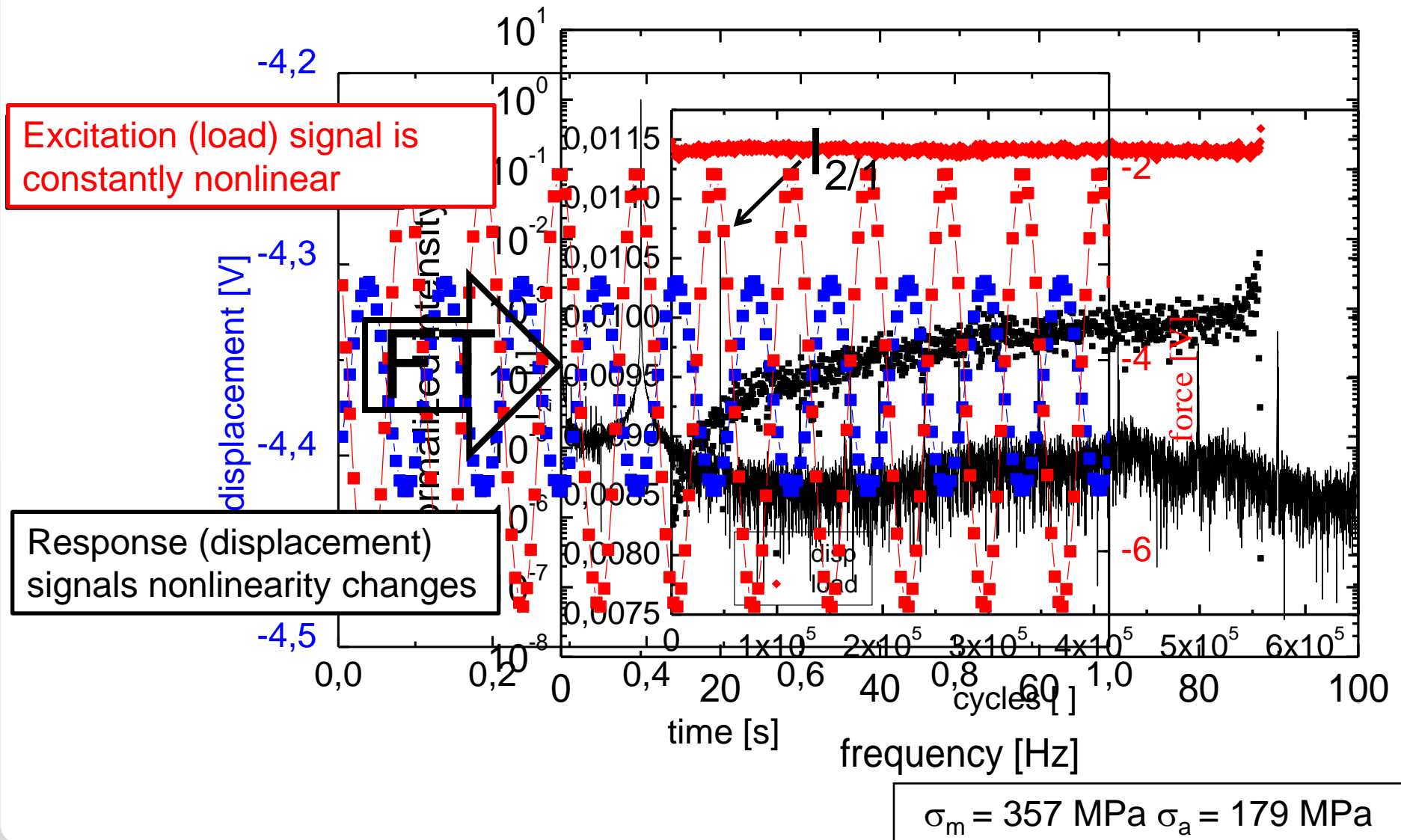
Cycling parameter

- 10 Hz

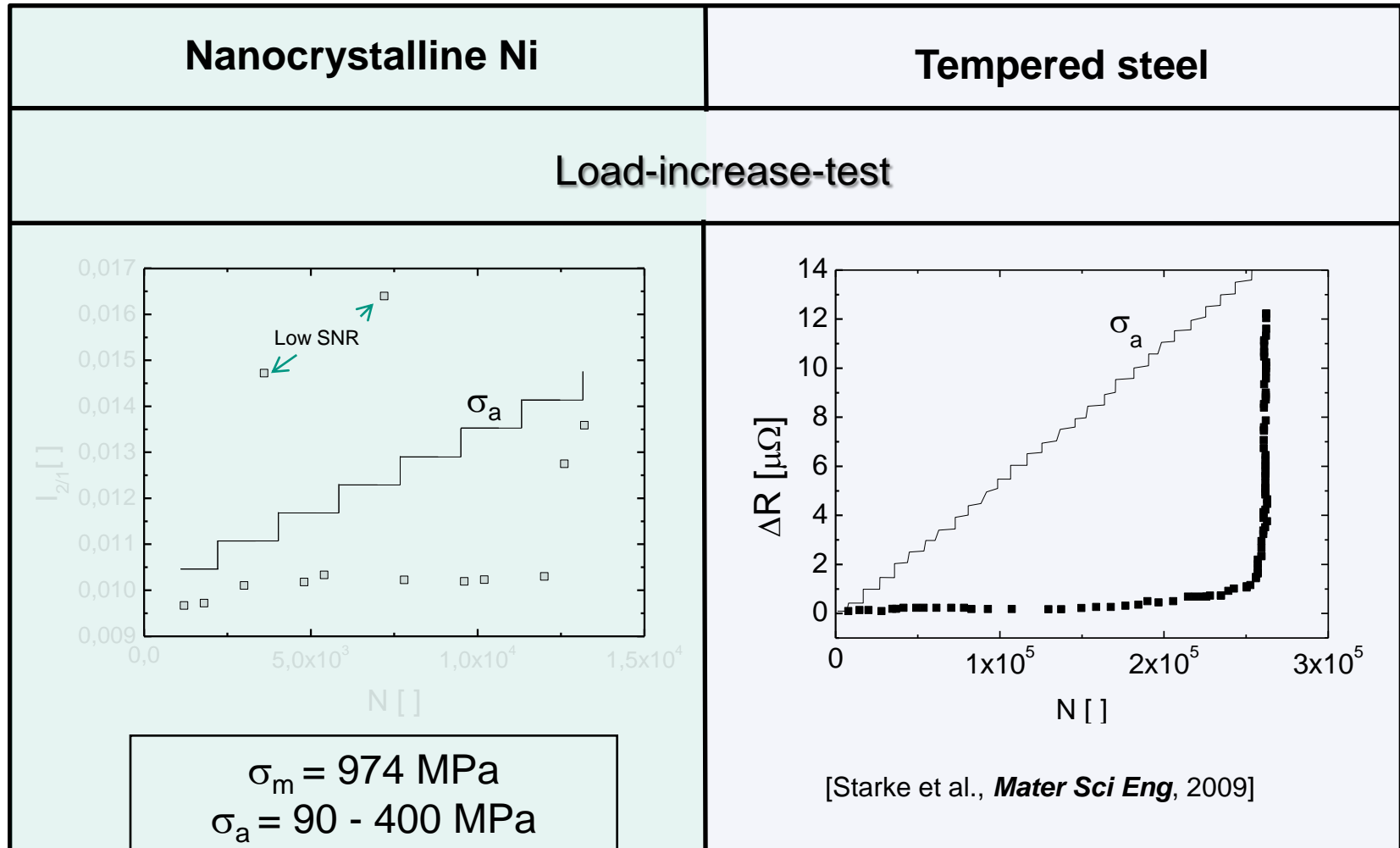
- $F_{\text{stat}} = 20 - 50 \text{ N}$ and $F_{\text{dyn}} = \text{up to } 23 \text{ N}$

- $T = \text{RT}$ (-150 – 500 °C possible)

FT-Analysis of fatigue test with nc-Ni



FT-Analysis of load increase tests



Summary

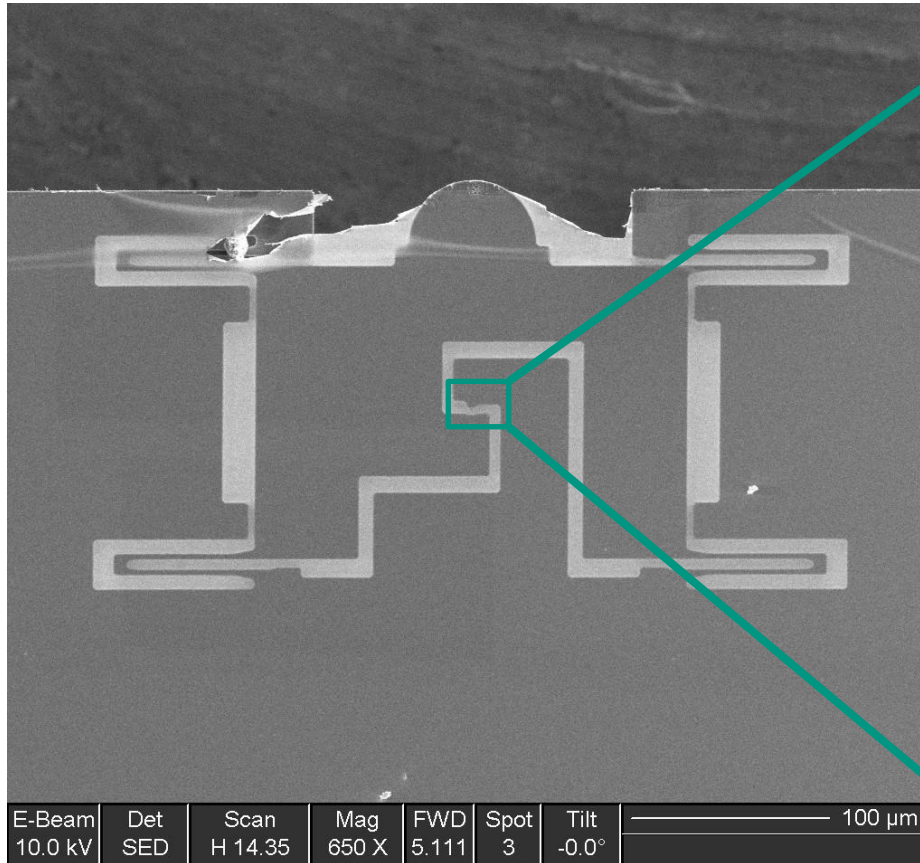
- Fatigue of nc-Ni: higher stress amplitudes between 10^4 and 10^7 cycles compared to cg-Ni
- TEM *in-situ* tensile and fatigue testing of nc-Cu: local strain of $\sim 9\%$ and ultimate strength of ~ 2 GPa - grain coarsening in fatigue
- nt-Cu: multiple slip \rightarrow necking. Detwinning in $2\ \mu\text{m}$ around the slip band
- Analysis of fatigue signals with FT: increase of nonlinearity at the end of fatigue life could be used for lifetime prediction (fatigue criteria)

Acknowledgement

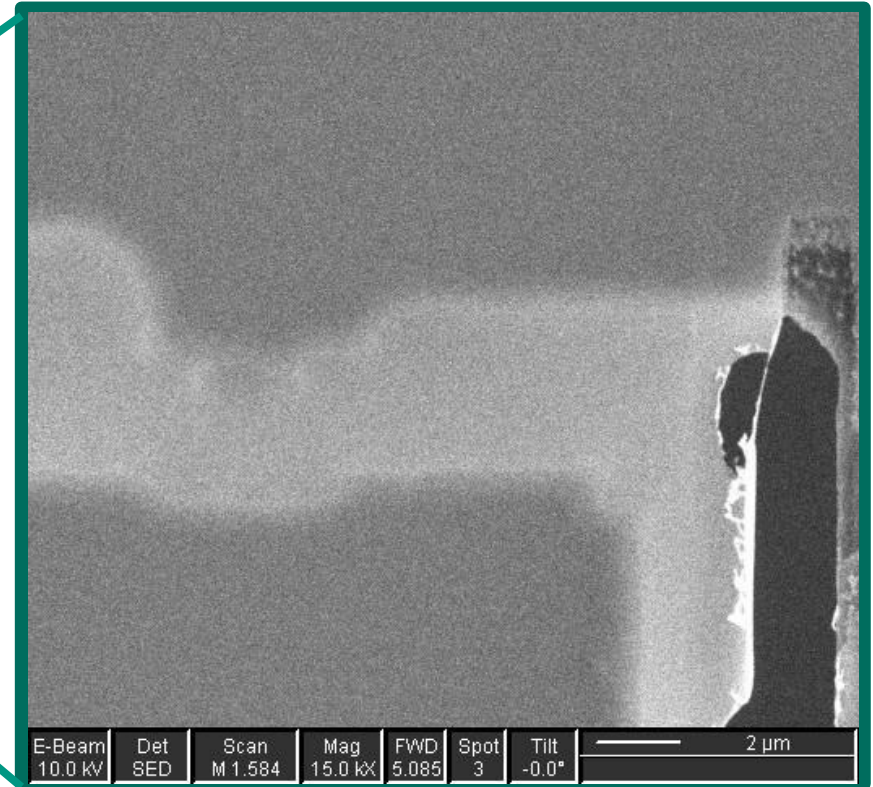
- Claire Cishholm, John Turner, Hua Guo for their help at the NCEM
- Tobias Kennerknecht, Ewald Ernst for their help with the bending setup

Thank you for your attention!

Cutting the Film



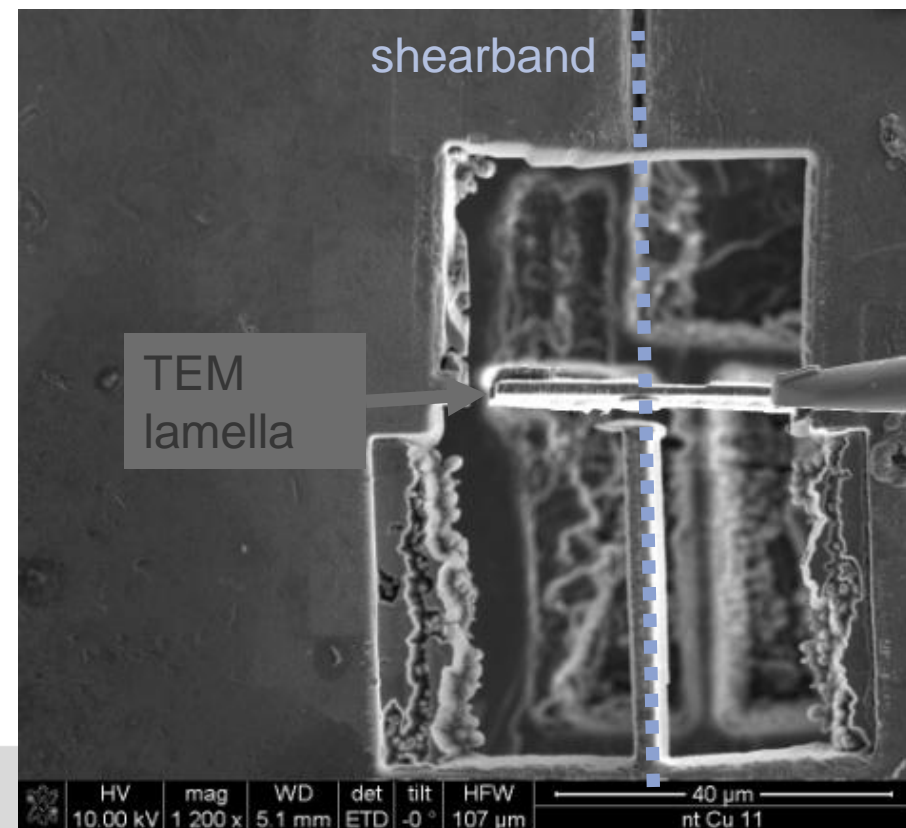
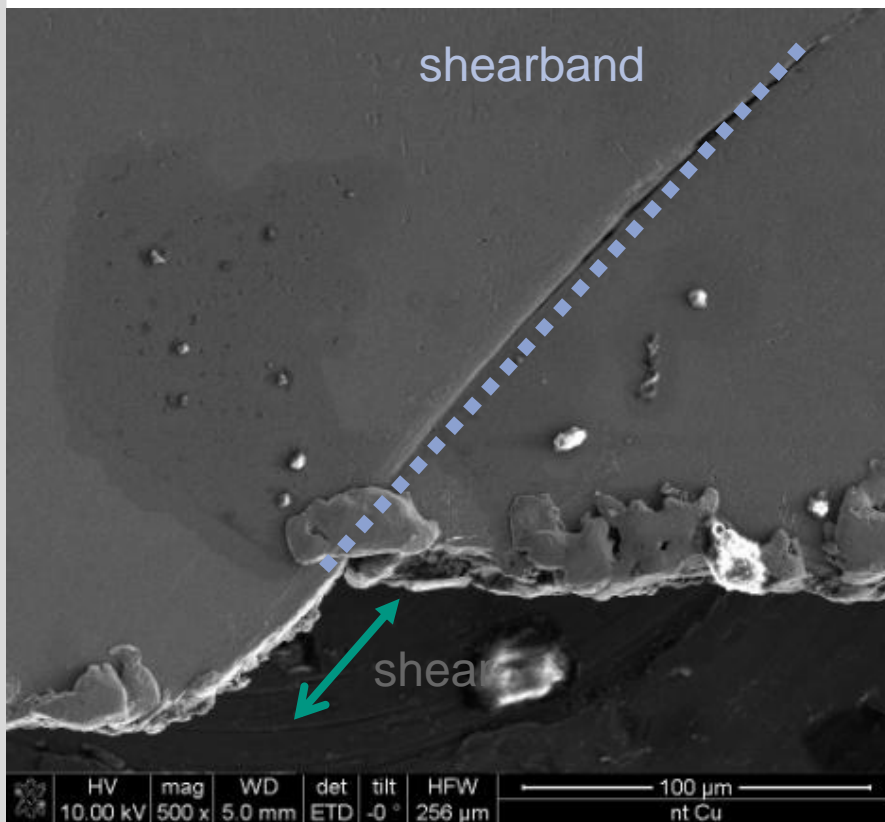
Off sample: 10 kx (reduced window),
1 - 3 nA



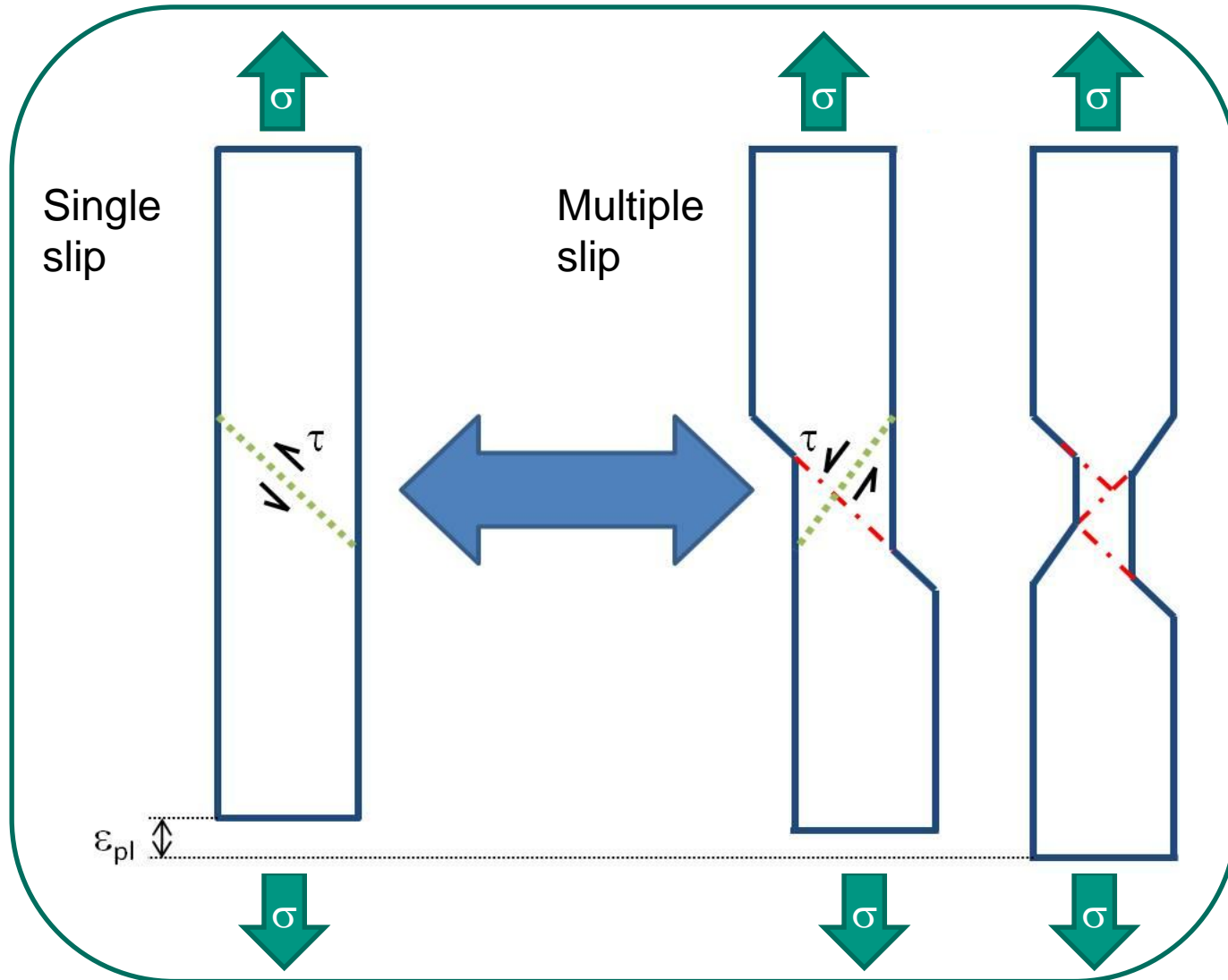
Close to sample: 15 kx (round
pattern), 50 - 100 pA

nt Cu 11

TEM Lamella with the shearband in the middle



Multiple shear - necking



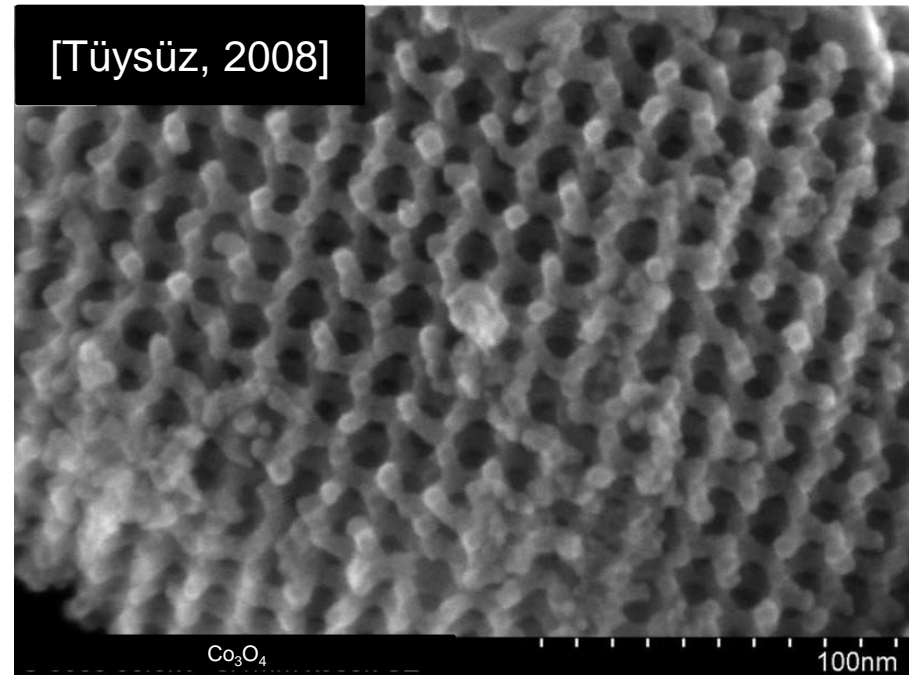
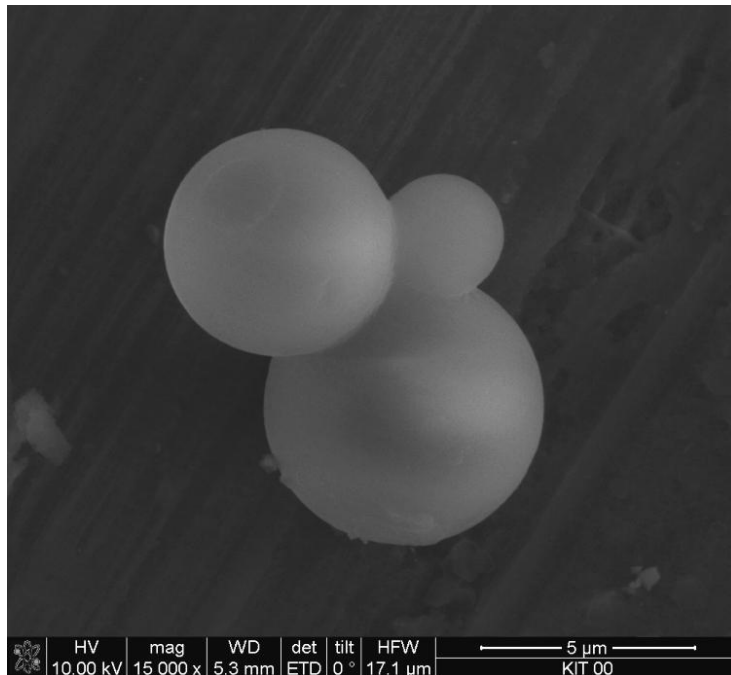
Dislocation source exhaustion \rightarrow multiple slip

necking

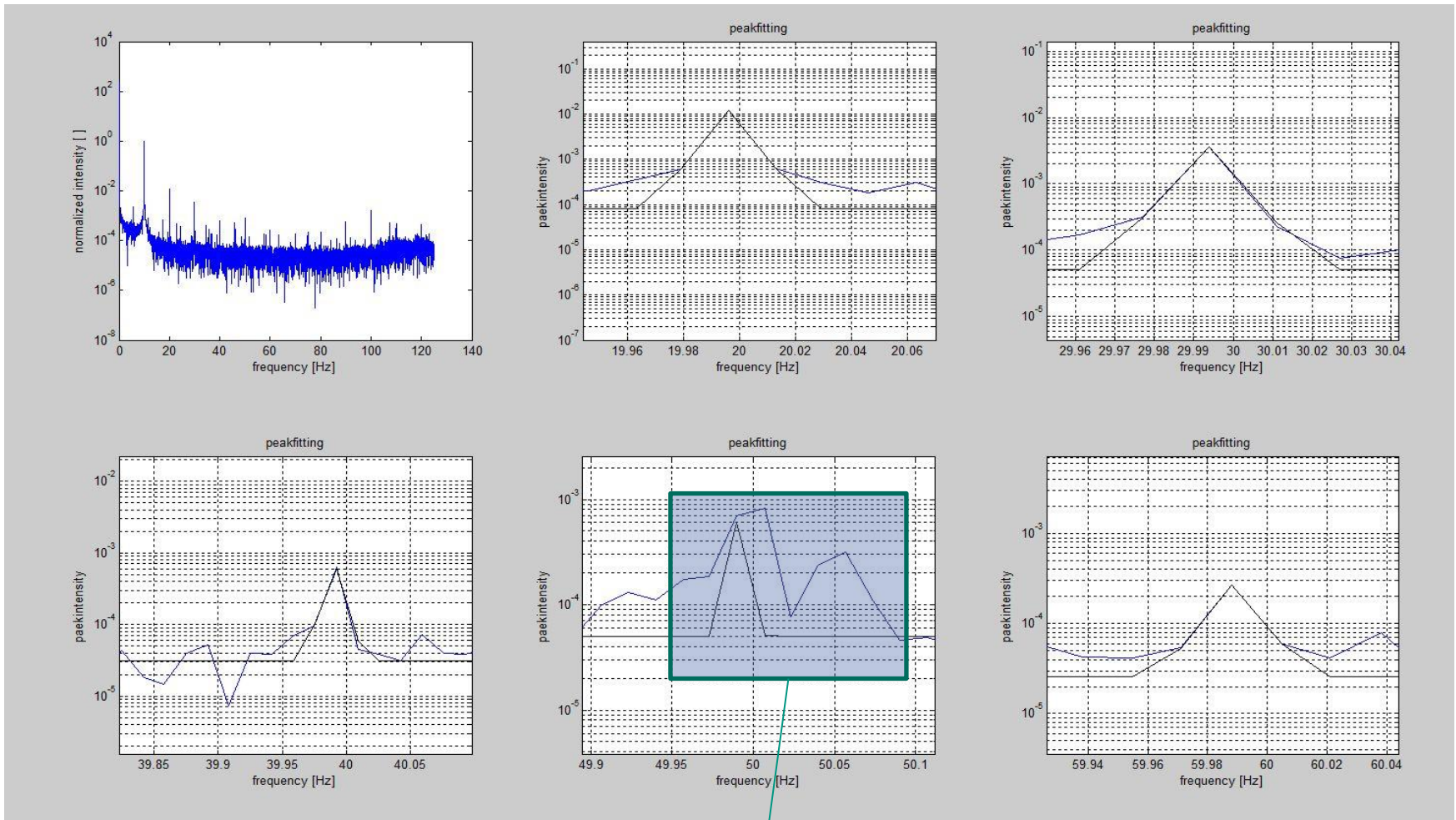
possible project – nanoporous materials

Nanoporous Co_3O_4 and ordered silicate hard template materials have promising properties for applications in catalysis industry, to investigate their mechanics:

- in-situ compression tests in the SEM
- ex-situ compression tests in the nanoindenter



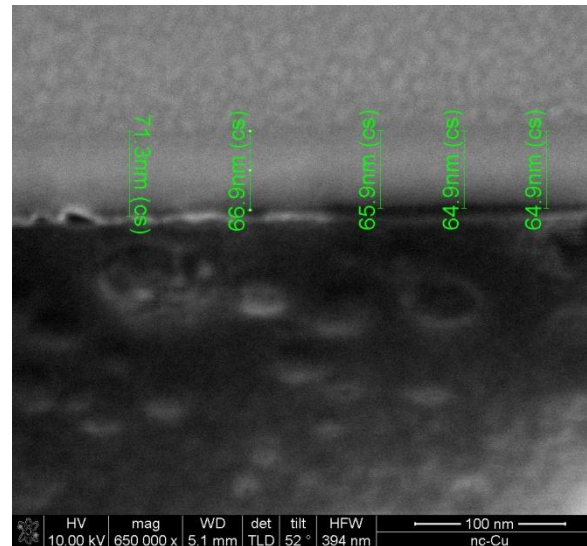
FT and peaks of 5 harmonics



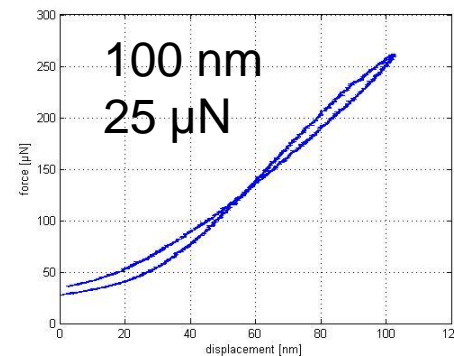
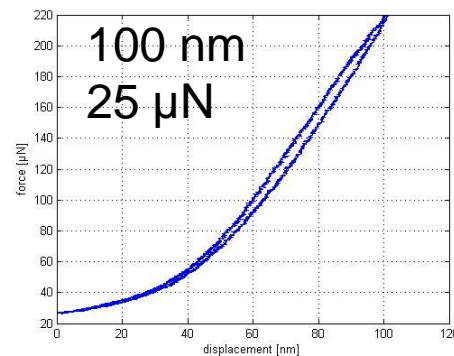
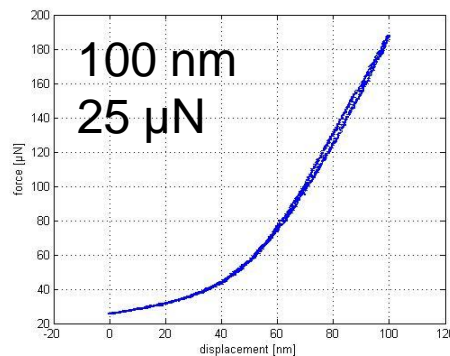
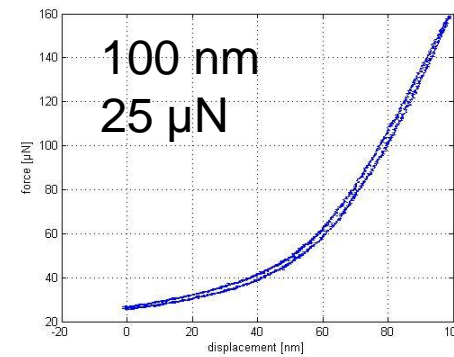
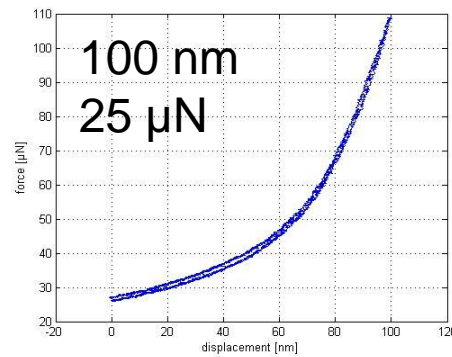
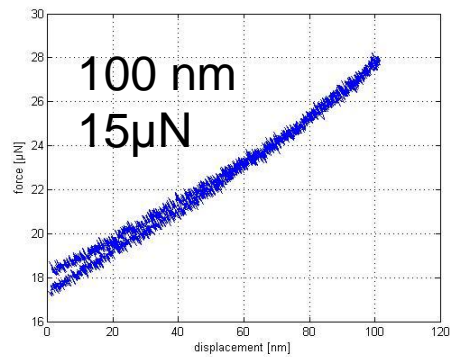
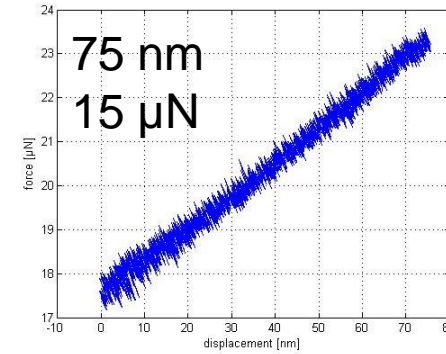
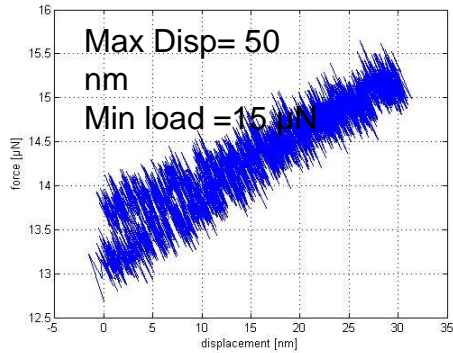
Frequency oscillations of 0.1 %, 0.05 Hz are normal (RWE)

Nonlinearity parameter

$$\beta_{\text{expt}} = \frac{8A_2}{A_1^2 k^2 x}$$

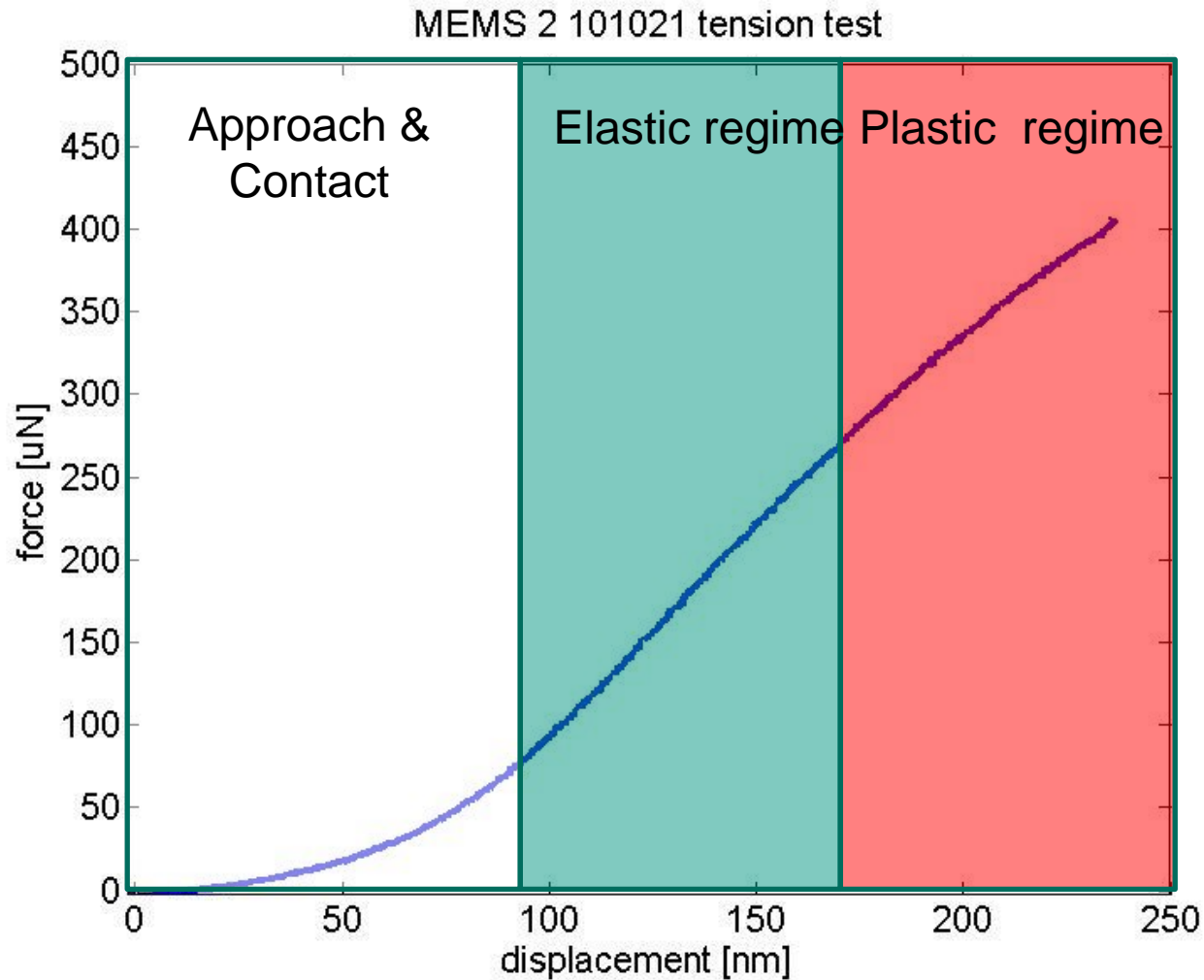
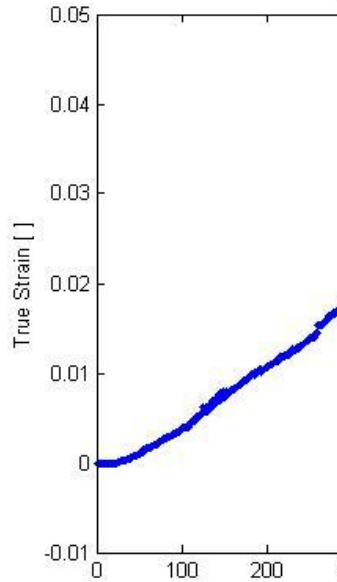


Loading curves

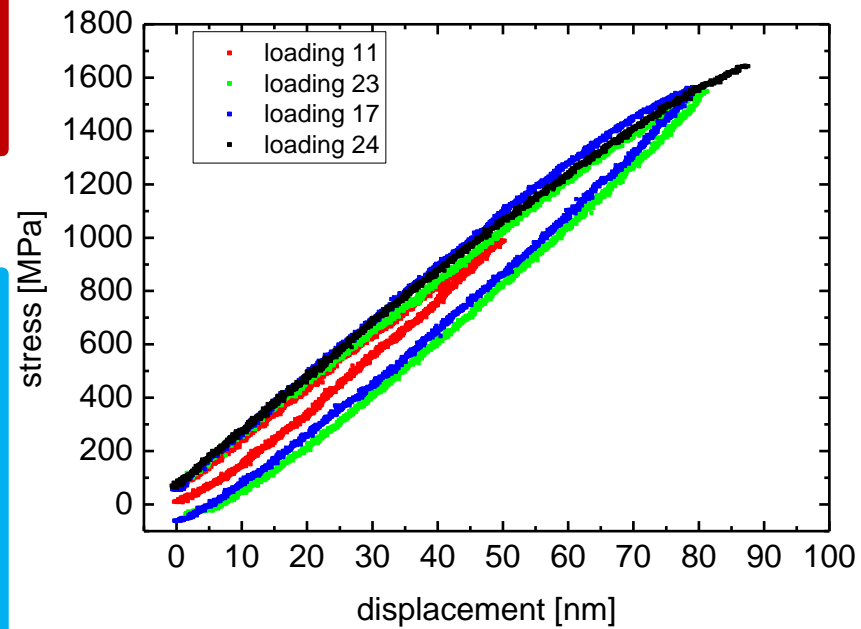
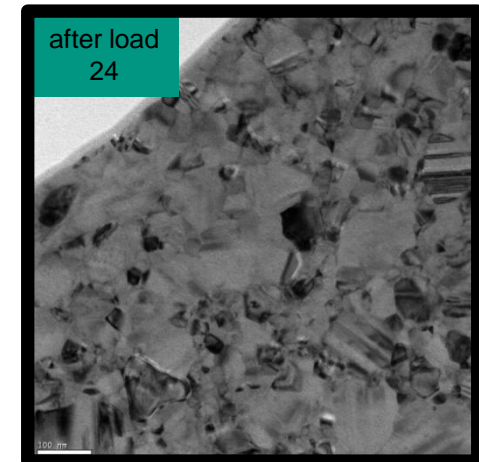
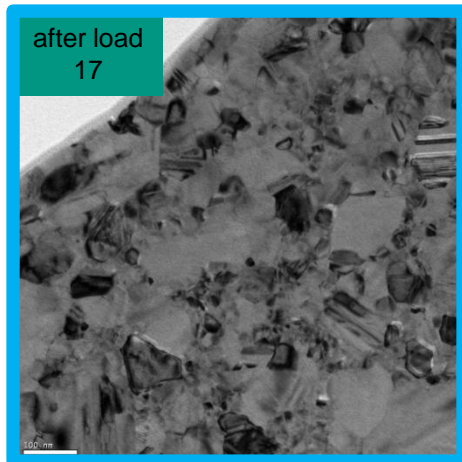
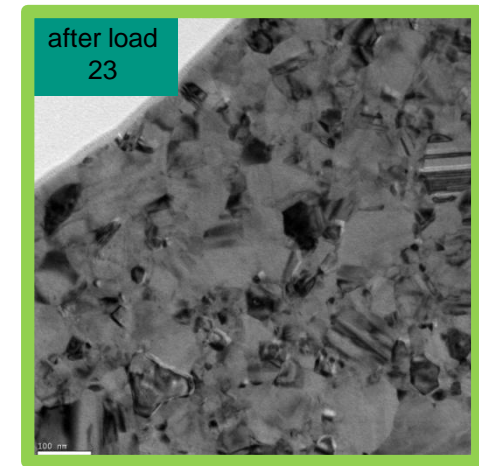
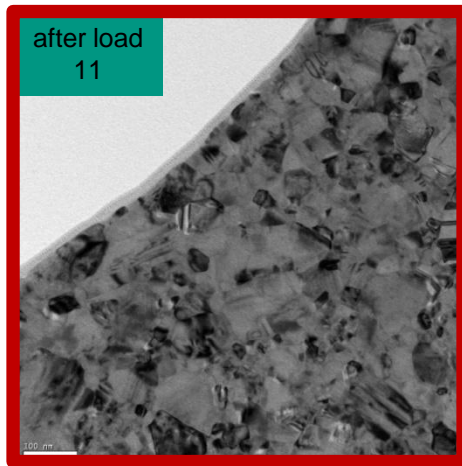


results

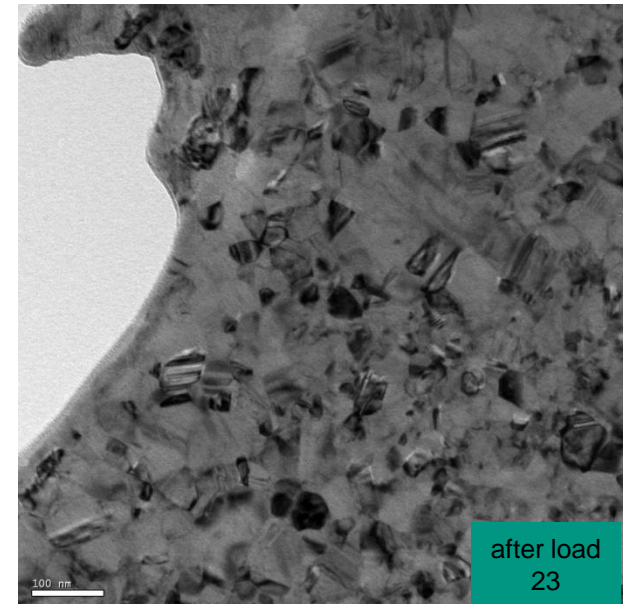
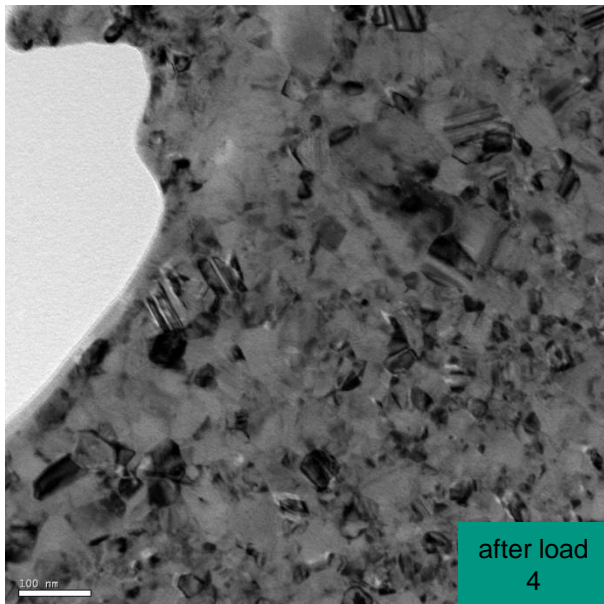
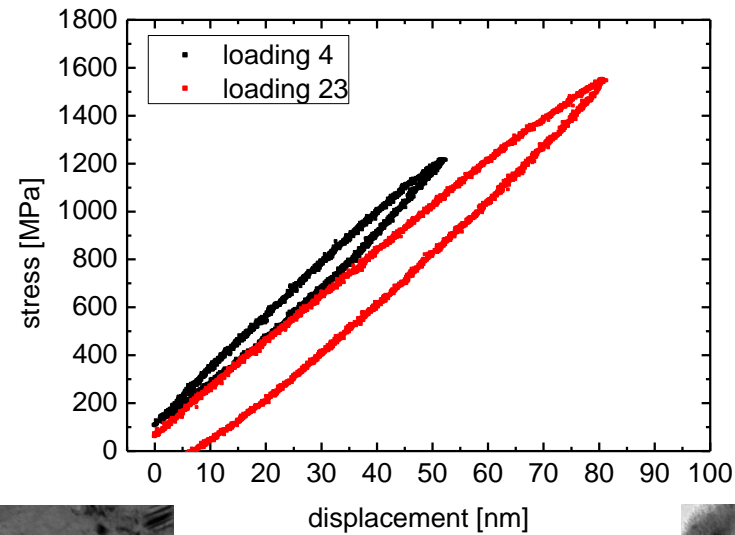
Strain



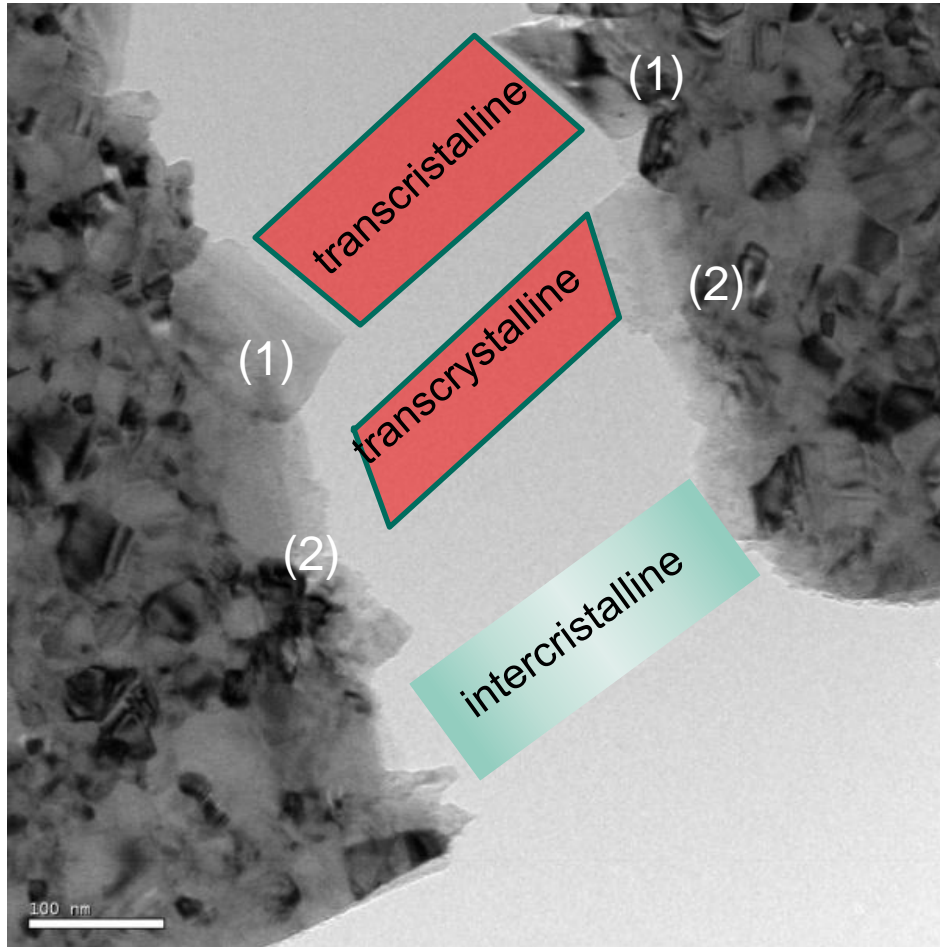
Grain coarsening Pos 1



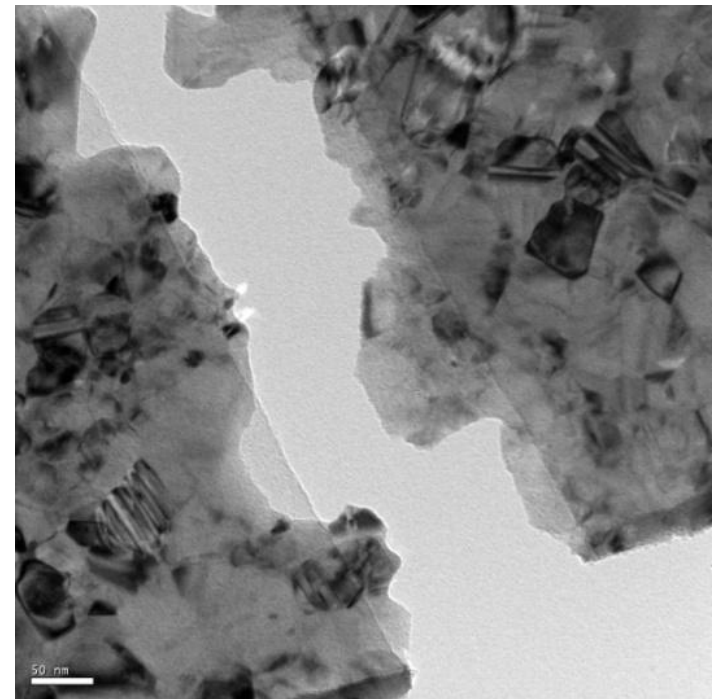
Grain coarsening



Fracture Morphology nc-Cu



Transcrystalline cracking in big grains (ufg); $d > 100$ nm
Intercrystalline cracking in smaller grains (nc); $d < 100$ nm



2K-injection moulding

Conductive ground plate
(1st component)

Change over

500 μ m

Pressing of
the structure

Insulating polymer
(2nd component)

Microdevice
removal

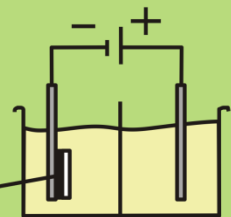
Demolding

Microdevice

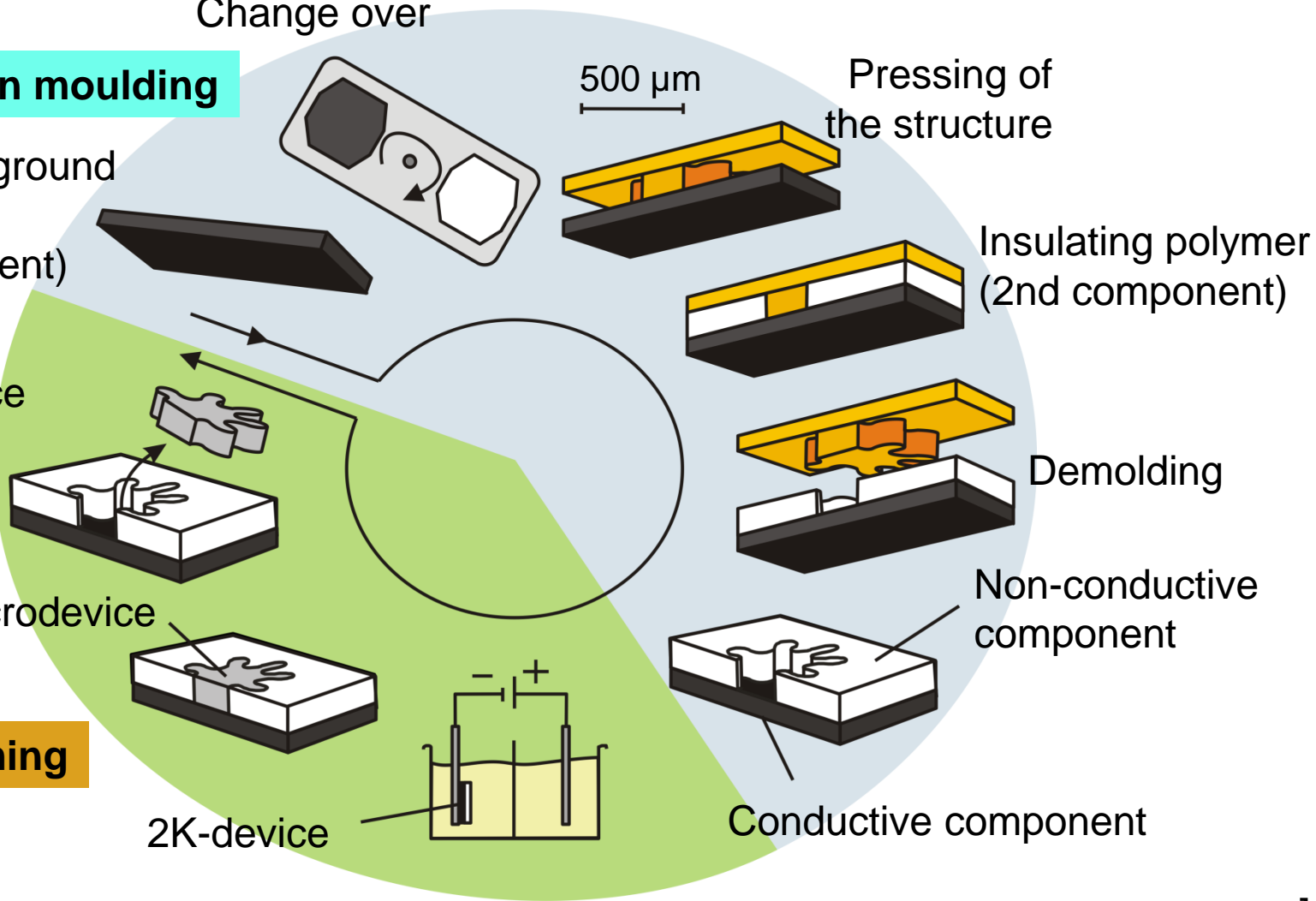
Non-conductive
component

electroforming

2K-device



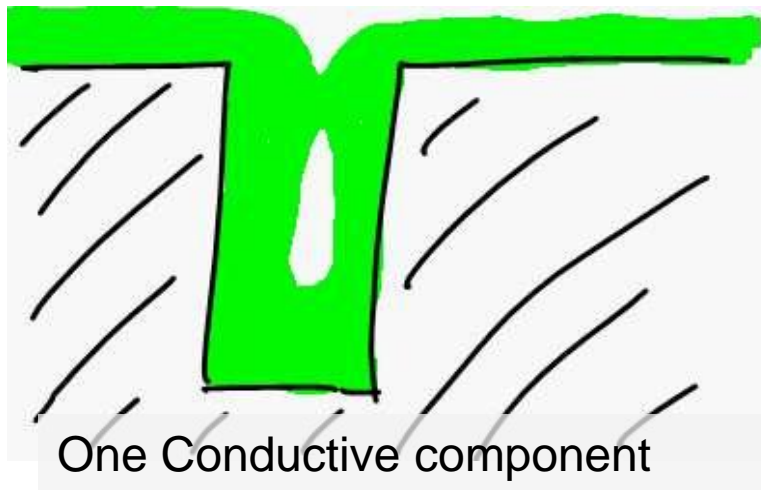
Conductive component



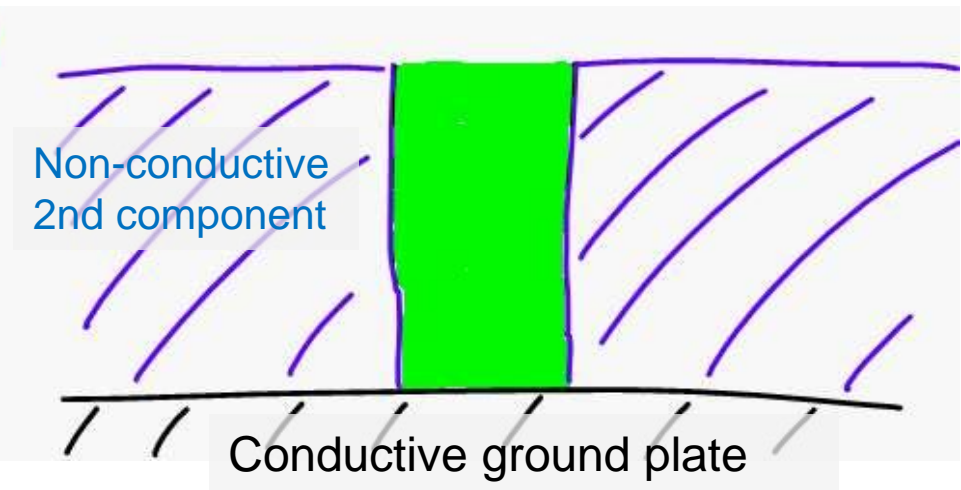
[Jürgen Prokop]

MSG - Motivation

Conventional electrodepositing

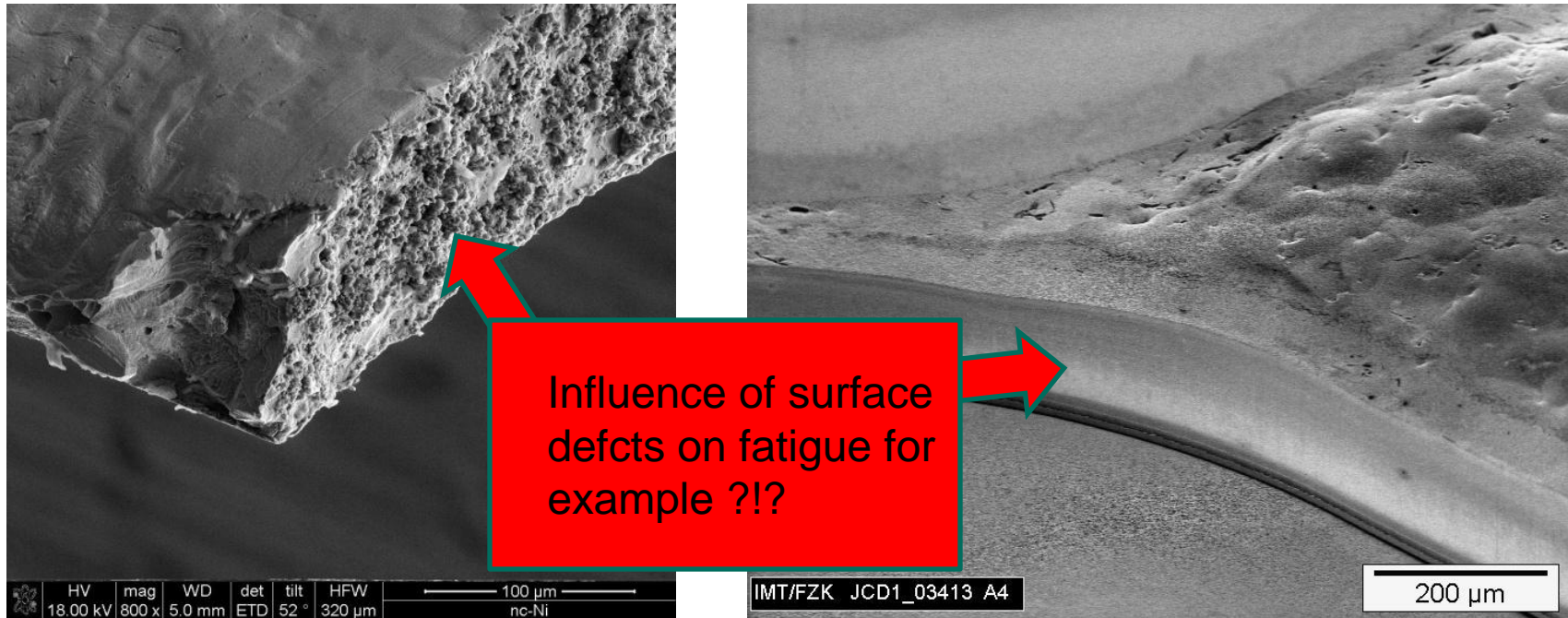


MSG - method



Benefit: no overgrowing
and no pores in
microparts with small
cavities

Comparison of surface quality



EDM-sample

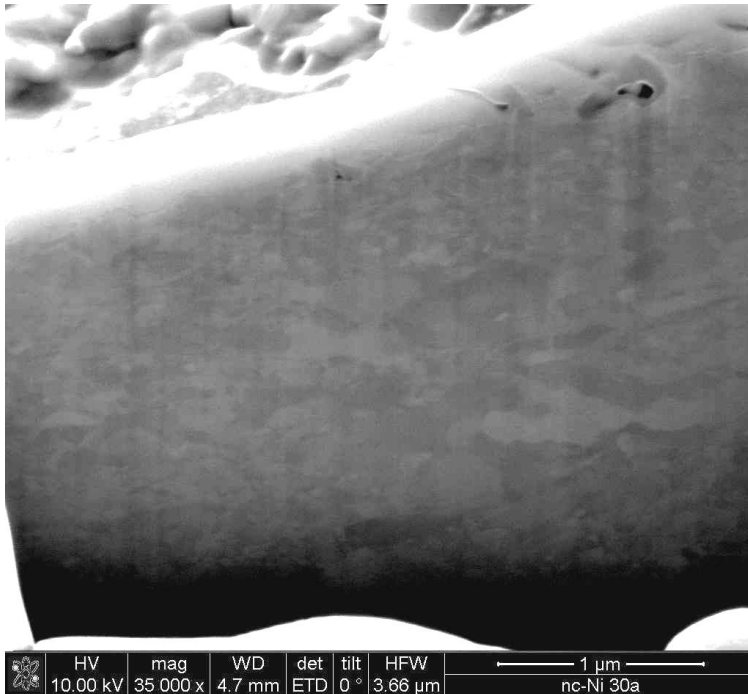
Electrodeposited
 Ni-5 at% W (LIGA) [Jürgen Prokop]

Benefit: Less defects in surface
 No surface layer (oxides, hydroxides)
 No heat affected zone

Grain coarsening - coalescence

Grain coarsening could be necessary to enable dislocation structures, which leads to failure

Grain rotation could lead to coalescence (grain coarsening).



[Meyers *Progr Mater Sci* 2006]